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Whetsel

(10) **Patent No.:** **US 9,213,061 B2**
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(54) **OPERATING STATE MACHINE FROM RESET TO POLL IN TO RESET**

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Related U.S. Application Data

(62) Division of application No. 13/855,970, filed on Apr. 3, 2013, now Pat. No. 8,880,966, which is a division of application No. 13/551,167, filed on Jul. 17, 2012, now Pat. No. 8,433,962, which is a division of

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G01R 31/317 (2006.01)

G01R 31/3185 (2006.01)

G06F 11/36 (2006.01)

G01R 31/28 (2006.01)

(52) **U.S. Cl.**

CPC **G01R 31/3172** (2013.01); **G01R 31/3177** (2013.01); **G01R 31/318541** (2013.01); **G01R 31/318572** (2013.01); **G06F 11/3656** (2013.01); **G01R 31/2815** (2013.01)

(58) **Field of Classification Search**

CPC G01R 31/3172; G01R 31/3177; G01R 31/318572; G01R 31/2815; G06F 11/3656

USPC 714/724, 726, 727, 731, 733
See application file for complete search history.

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Primary Examiner — Cynthia Britt

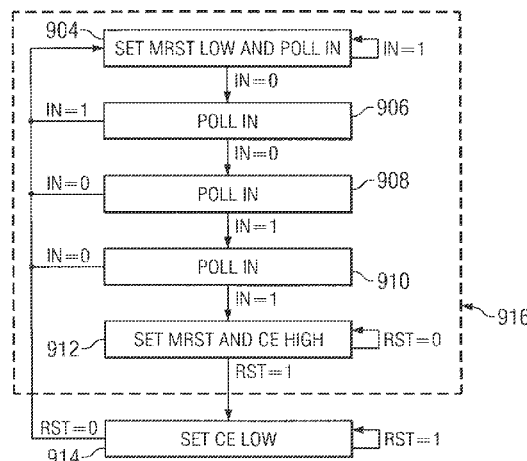
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(57)

ABSTRACT

An optimized JTAG interface is used to access JTAG Tap Domains within an integrated circuit. The interface requires fewer pins than the conventional JTAG interface and is thus more applicable than conventional JTAG interfaces on an integrated circuit where the availability of pins is limited. The interface may be used for a variety of serial communication operations such as, but not limited to, serial communication related integrated circuit test, emulation, debug, and/or trace operations.

7 Claims, 21 Drawing Sheets



Related U.S. Application Data

application No. 13/197,000, filed on Aug. 3, 2011, now Pat. No. 8,250,421, which is a division of application No. 13/012,117, filed on Jan. 24, 2011, now Pat. No. 8,020,059, which is a division of application No. 12/887,672, filed on Sep. 22, 2010, now Pat. No. 7,900,110, which is a division of application No. 12/640,941, filed on Dec. 17, 2009, now Pat. No. 7,823,037, which is a division of application No. 12/182,605, filed on Jul. 30, 2008, now Pat. No. 7,669,099, which is a division of application No. 11/370,017, filed on Mar. 7, 2006, now Pat. No. 7,421,633.

- (60) Provisional application No. 60/663,953, filed on Mar. 21, 2005.

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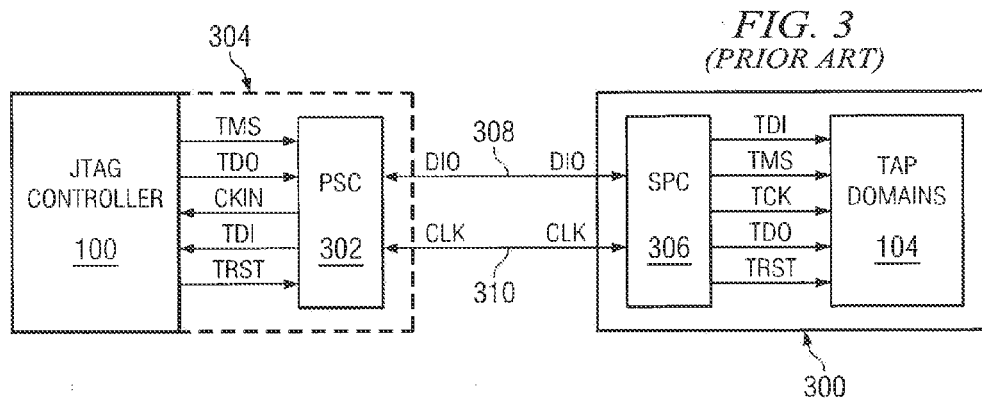
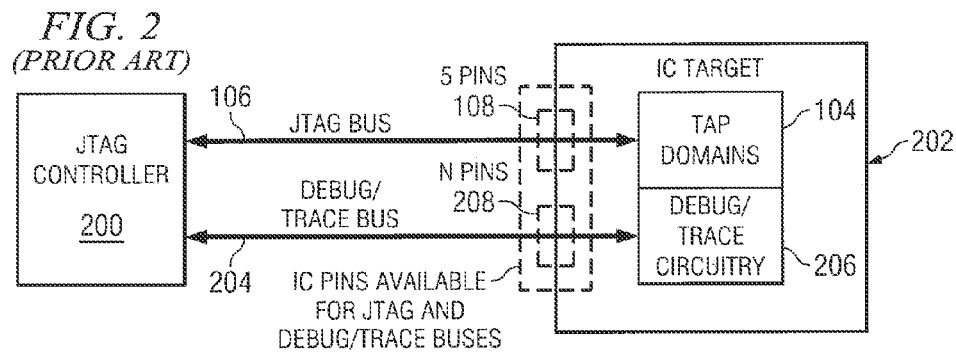
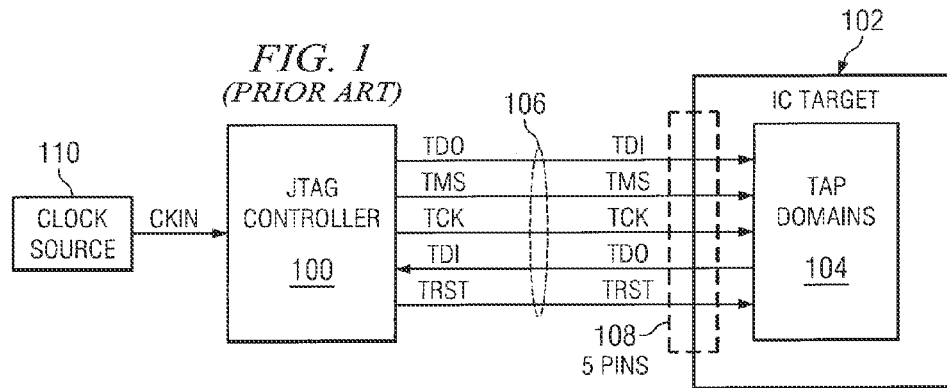


FIG. 4A
(PRIOR ART)

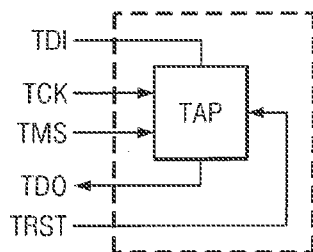


FIG. 4B
(PRIOR ART)

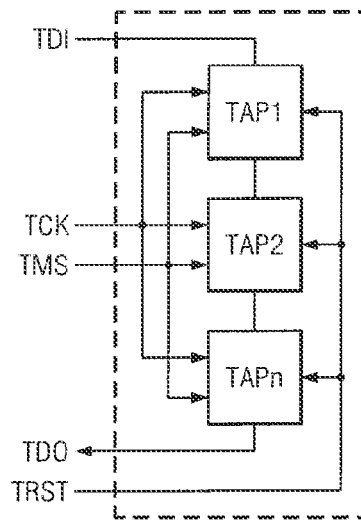
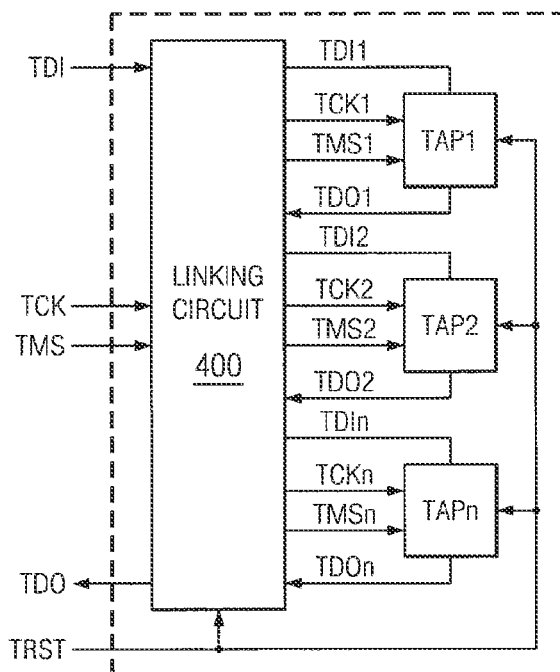


FIG. 4C
(PRIOR ART)



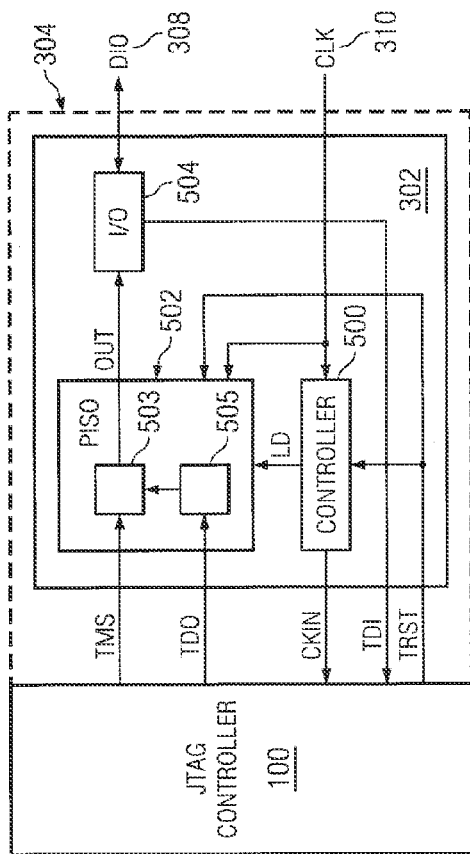


FIG. 5A

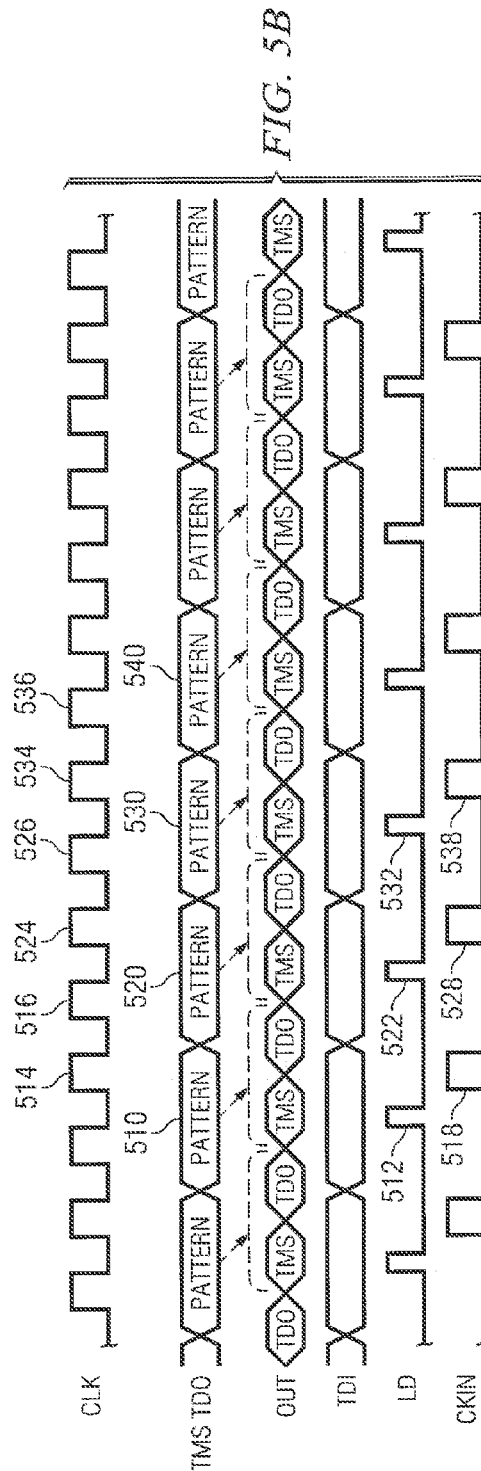
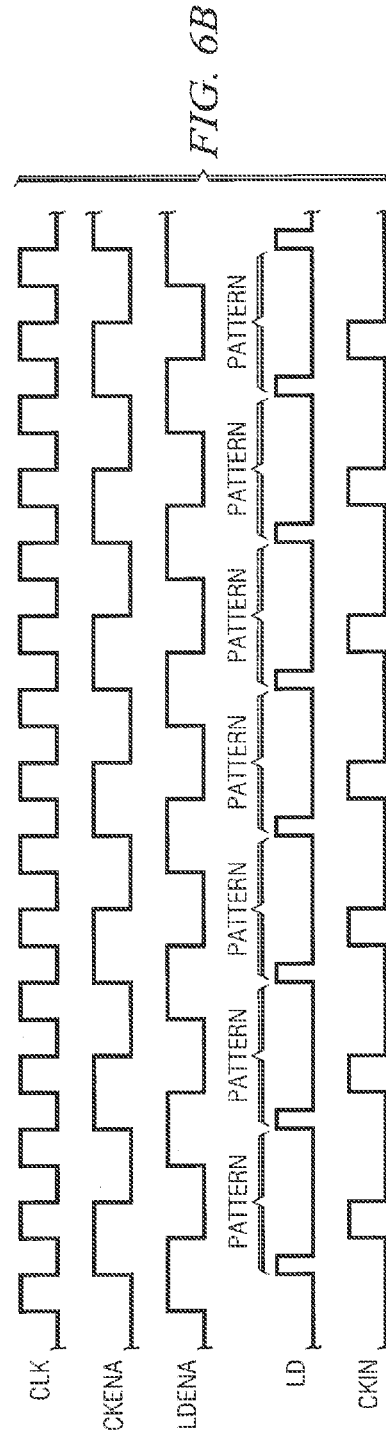
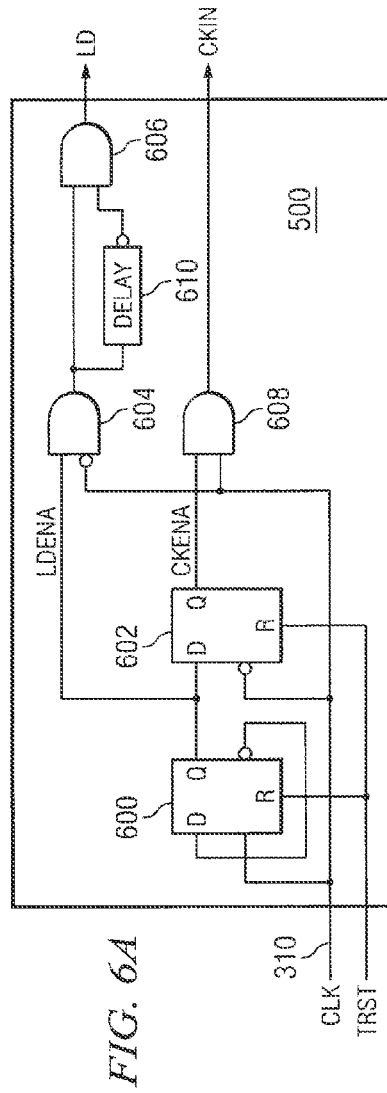
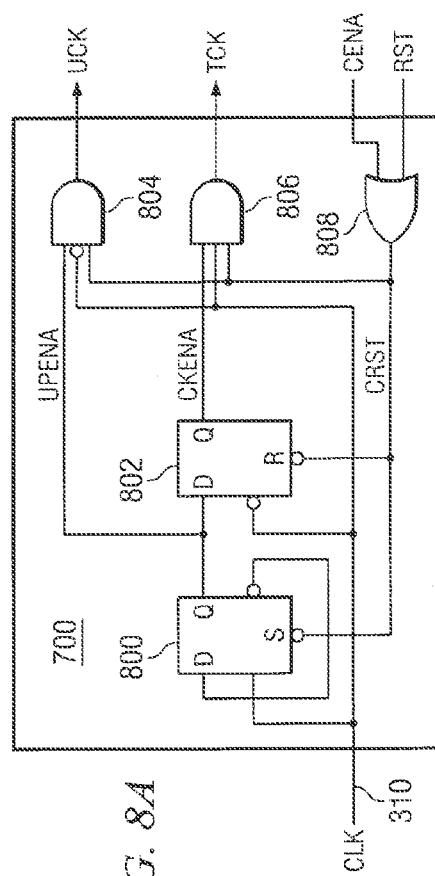
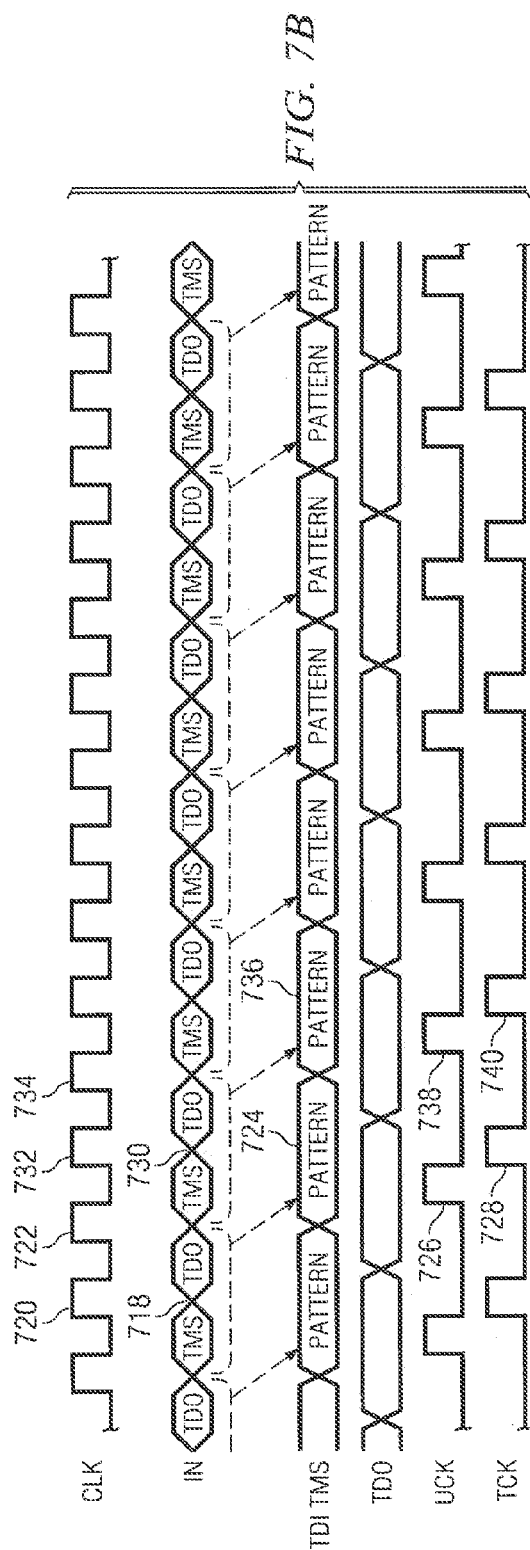
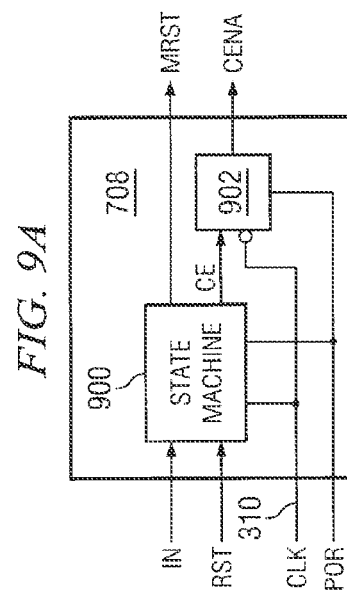
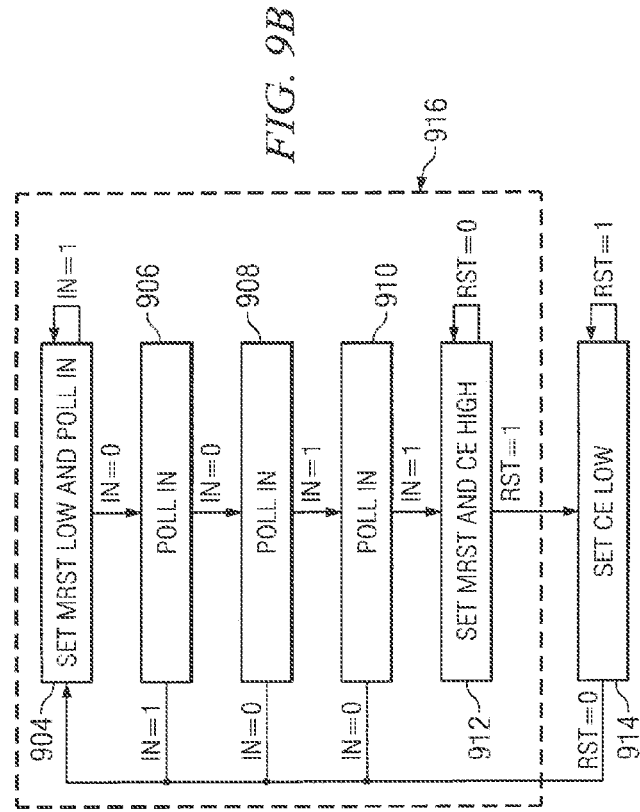
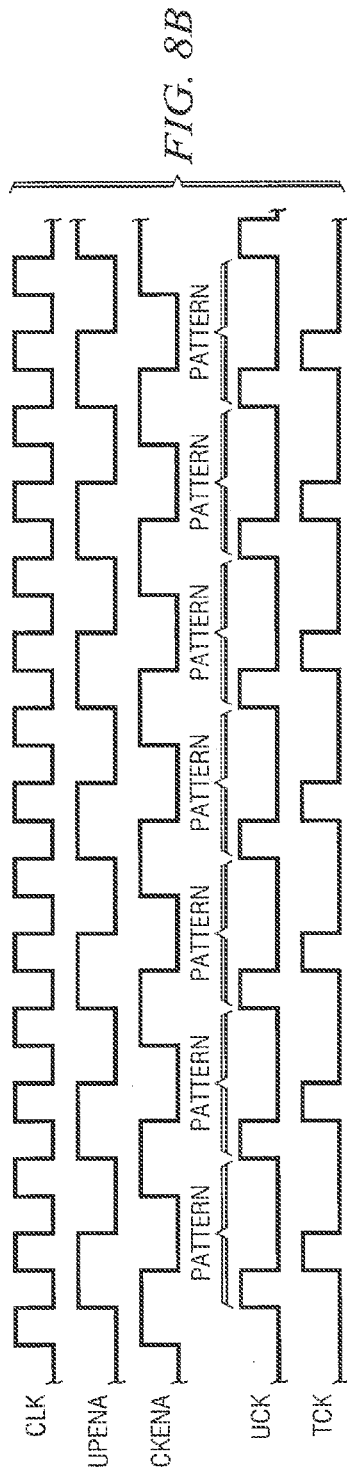


FIG. 5B







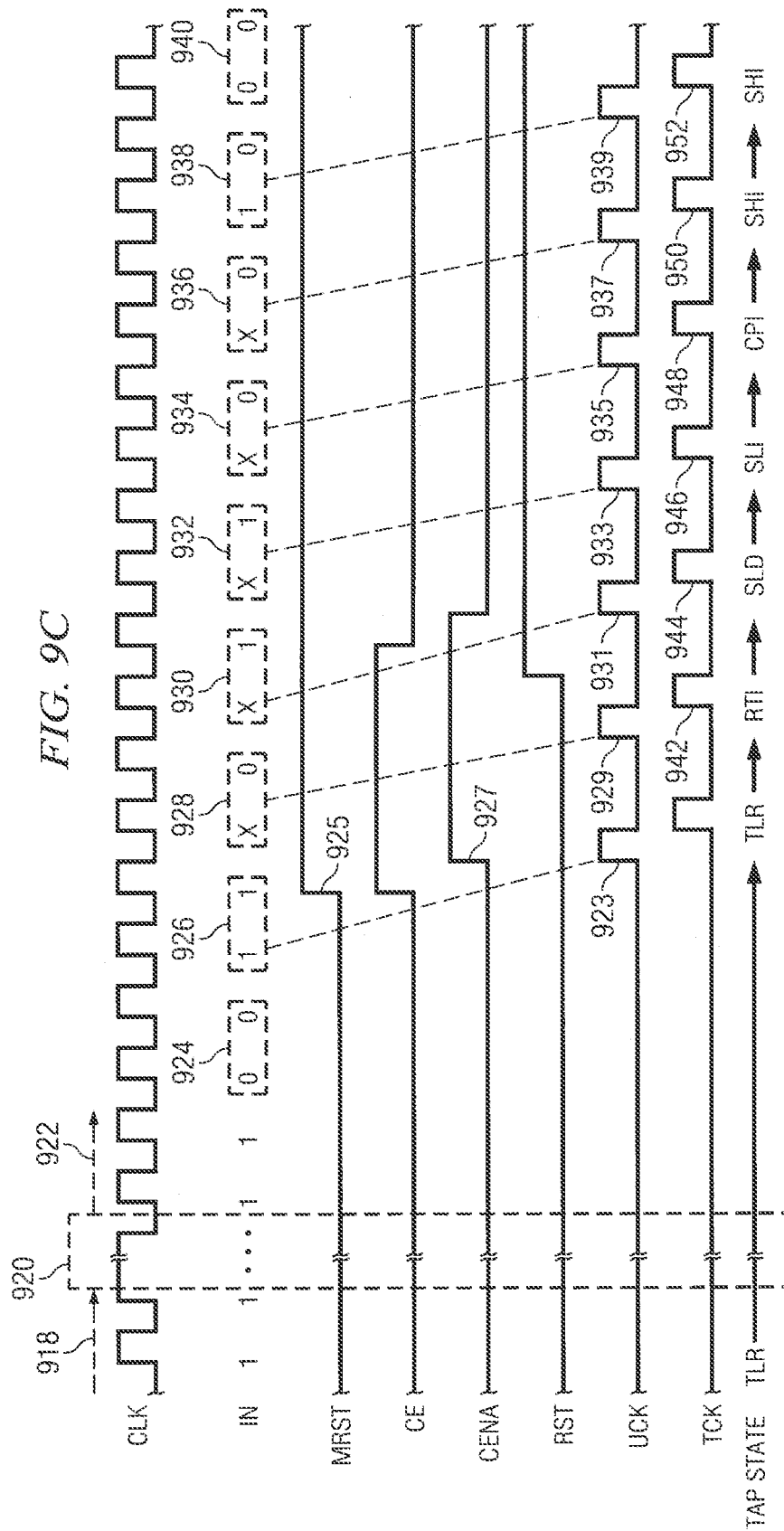
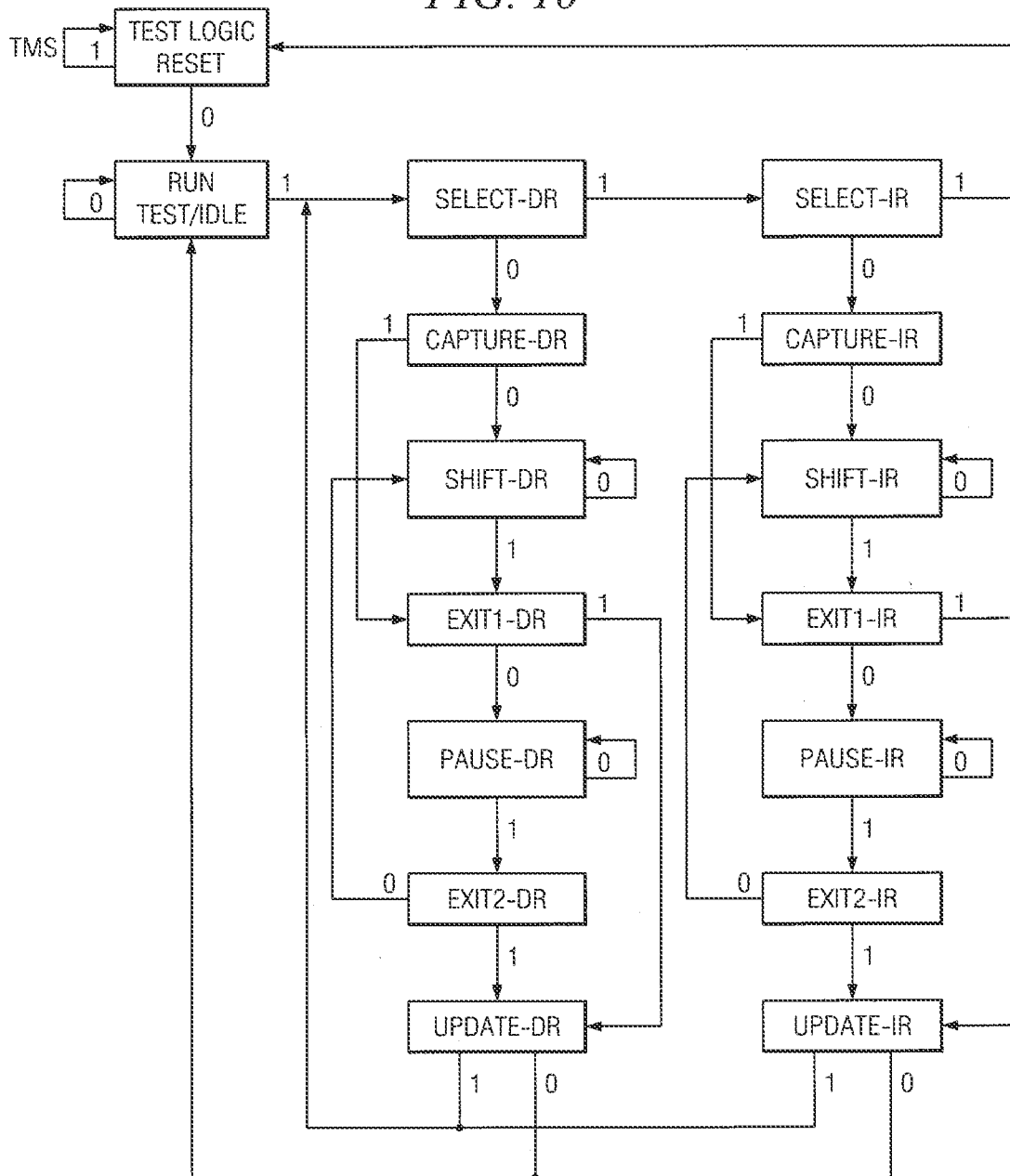


FIG. 10



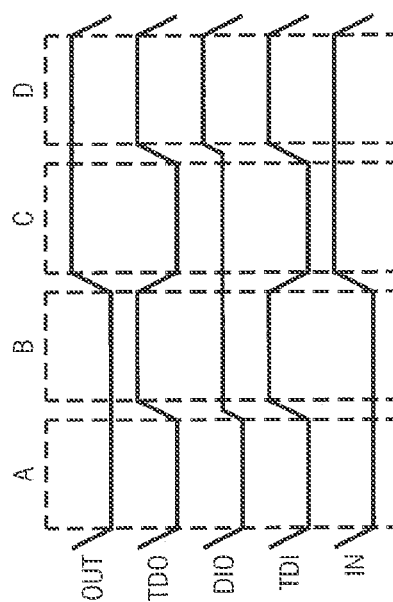
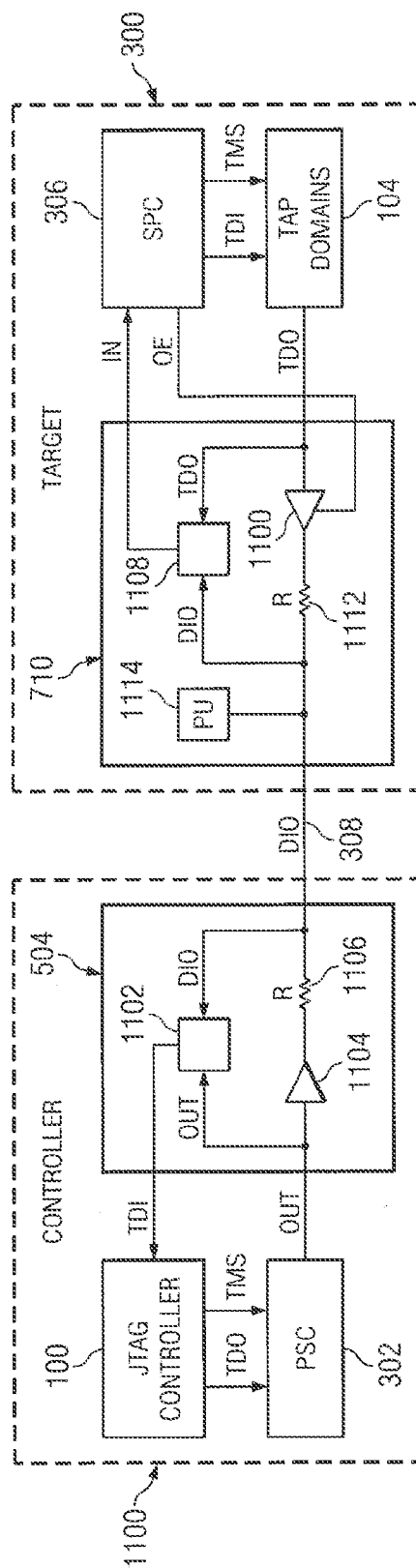


FIG. 12

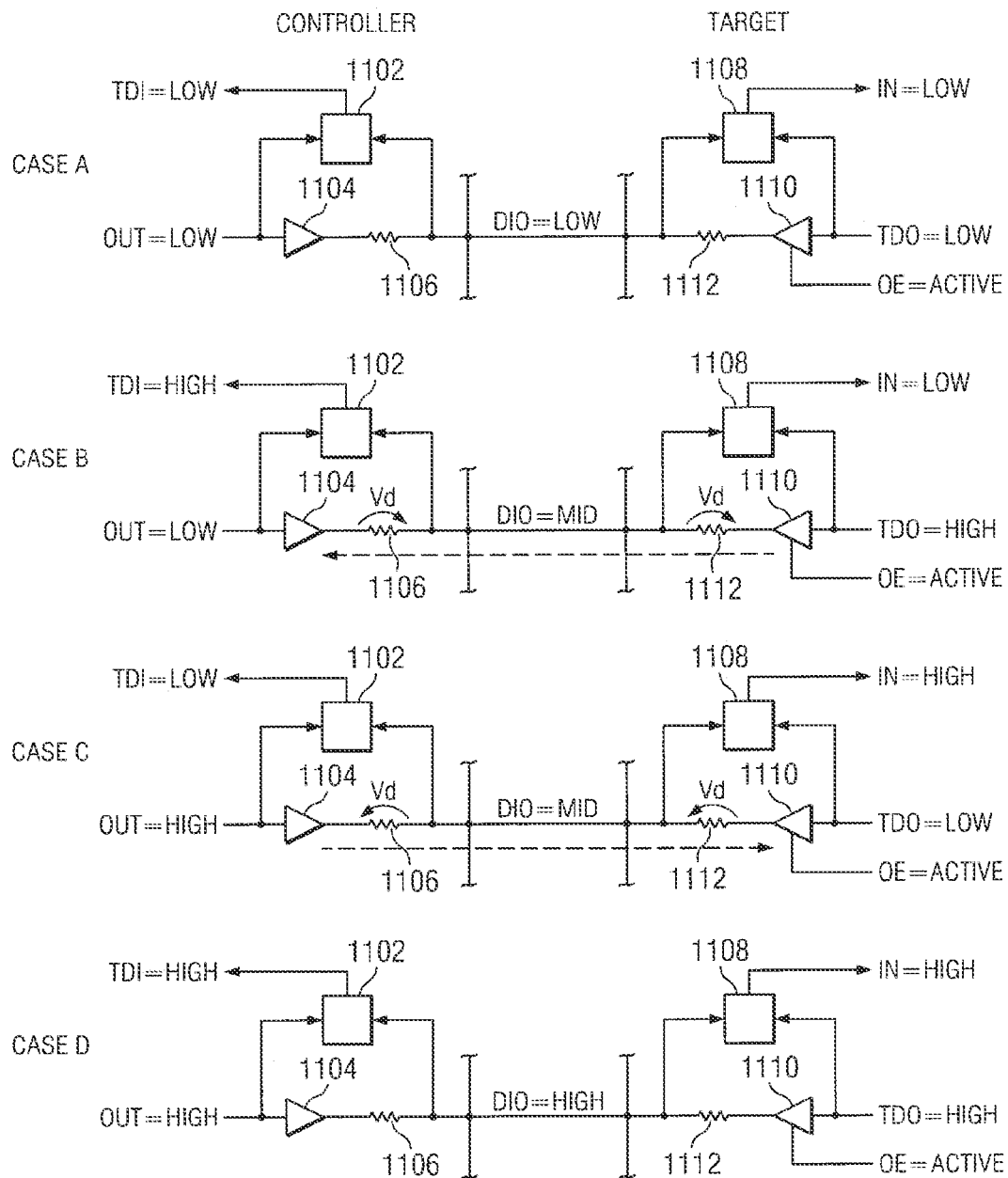


FIG. 13A

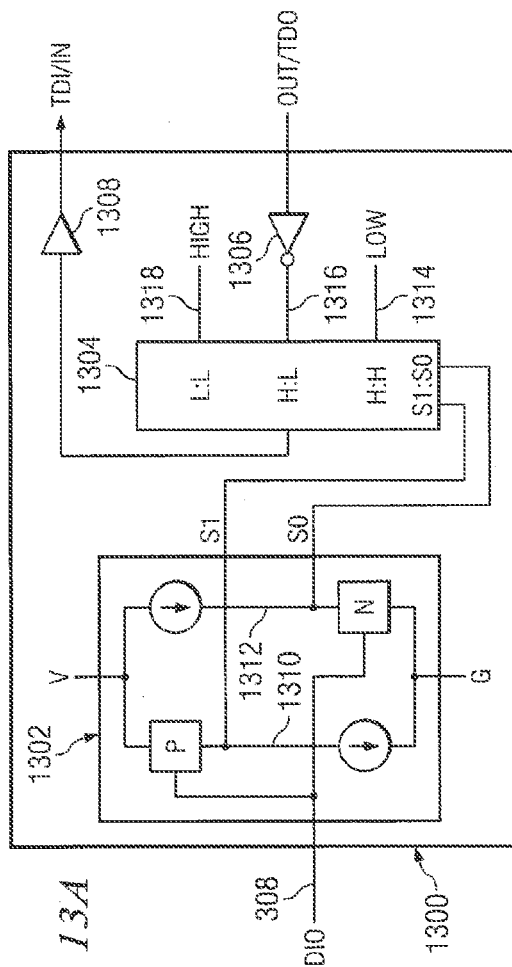
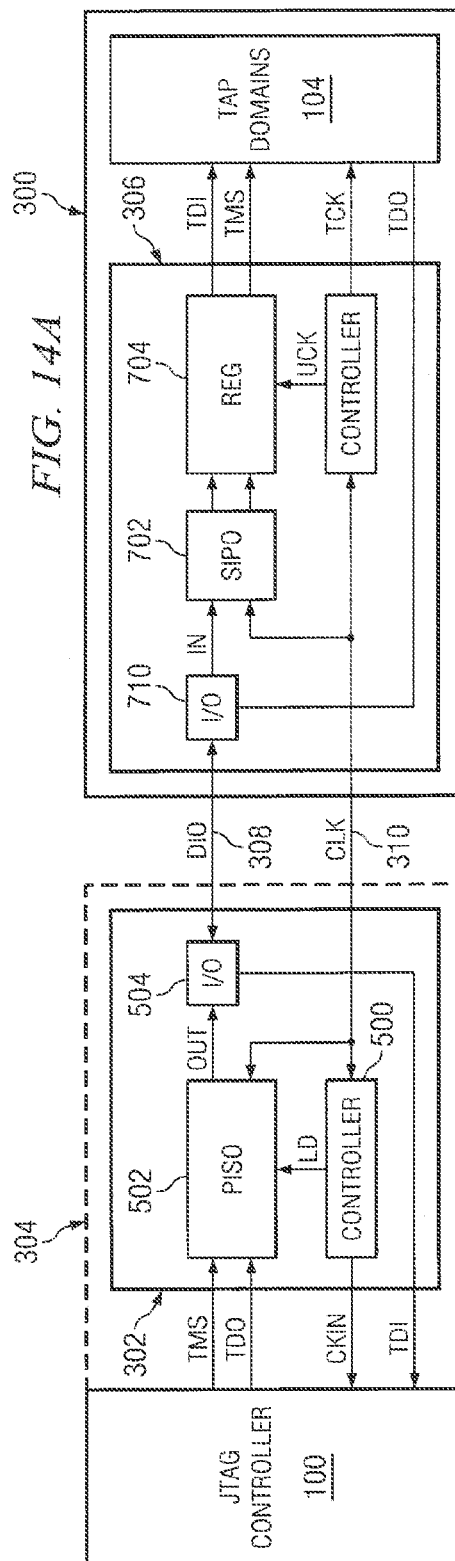


FIG. 13B

DIO	S1:S0	TDI/IN
LOW	H:H	LOW
MID	H:L	OUT*/TDO*
HIGH	L:L	HIGH

FIG. 14A



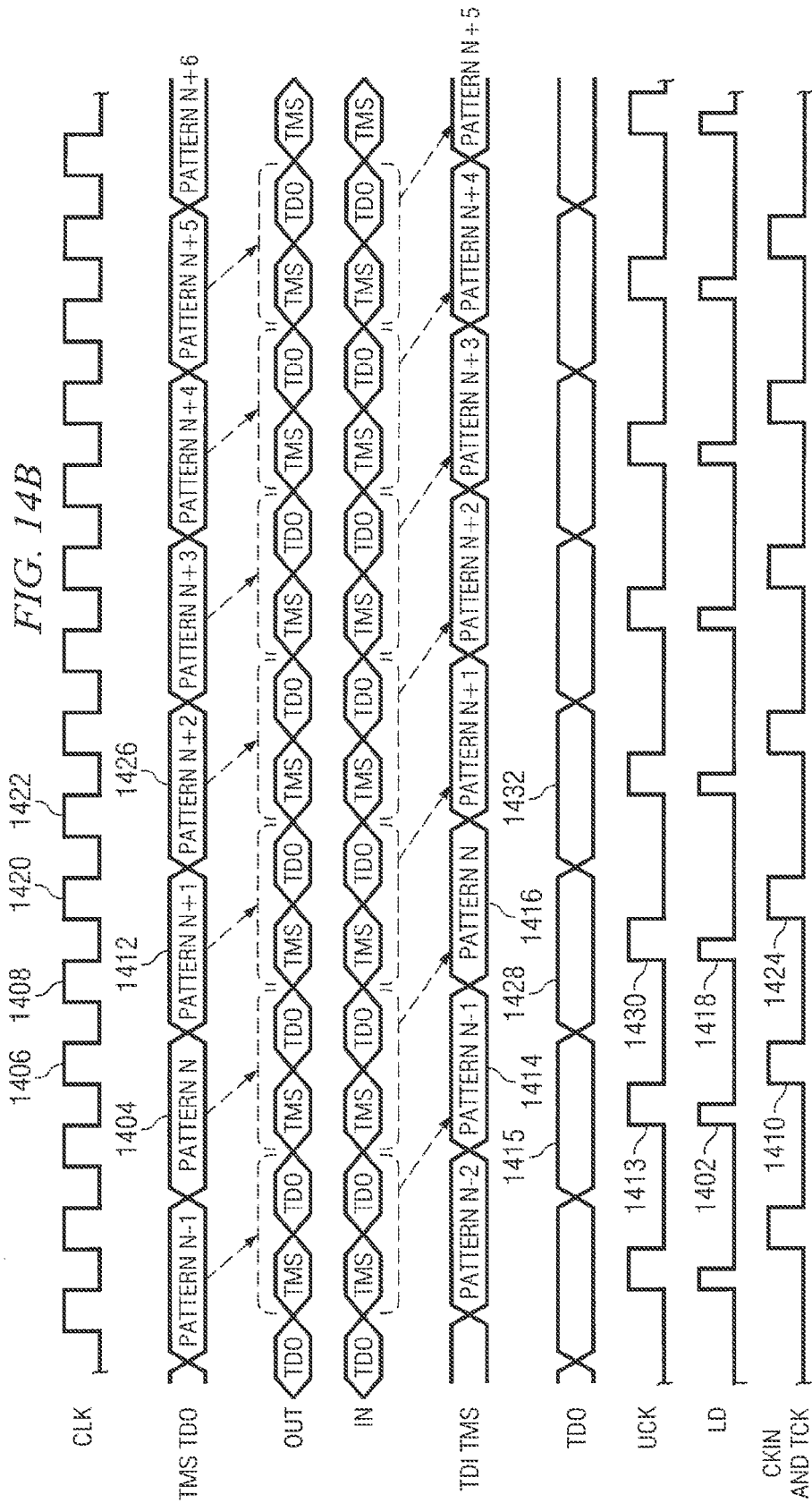
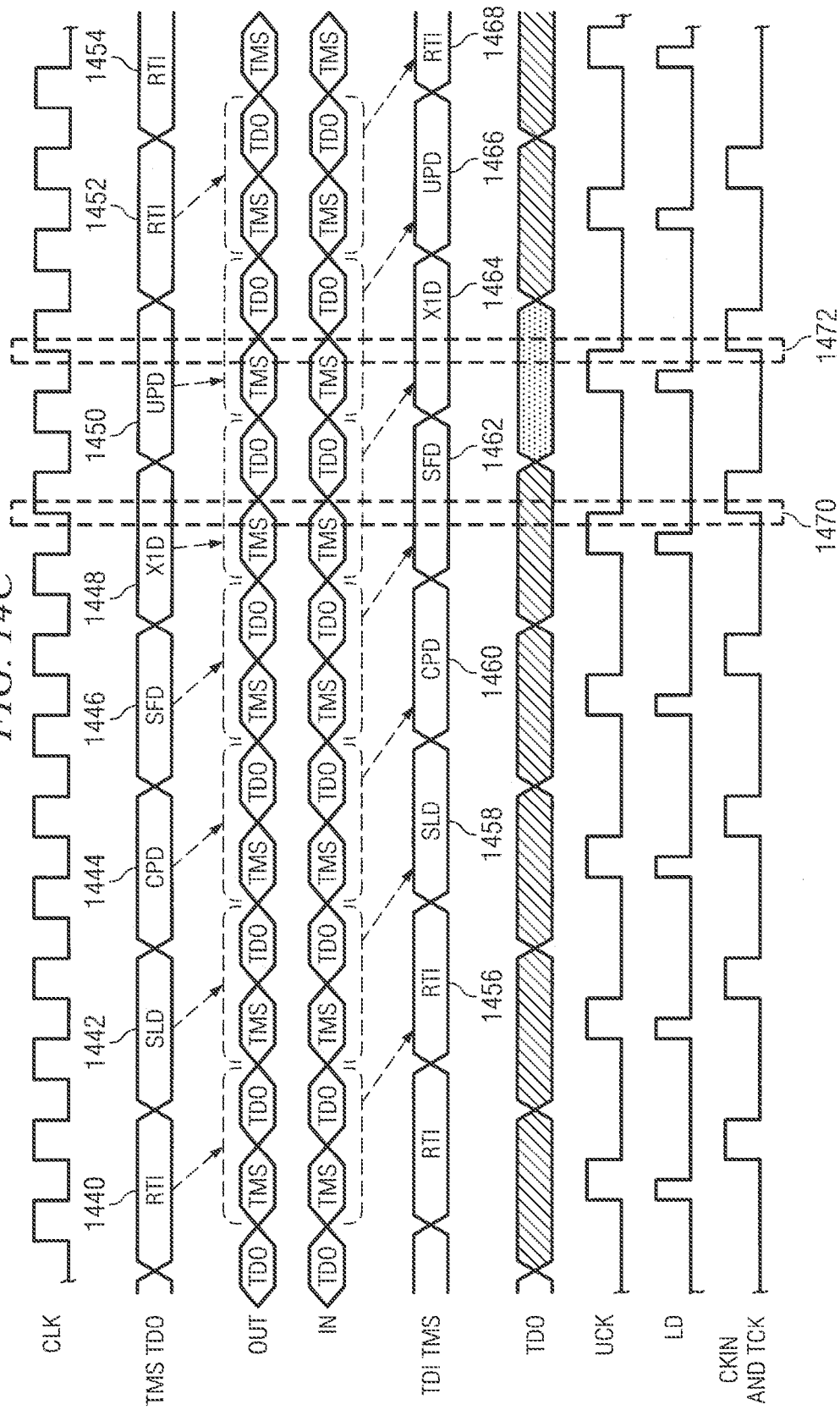
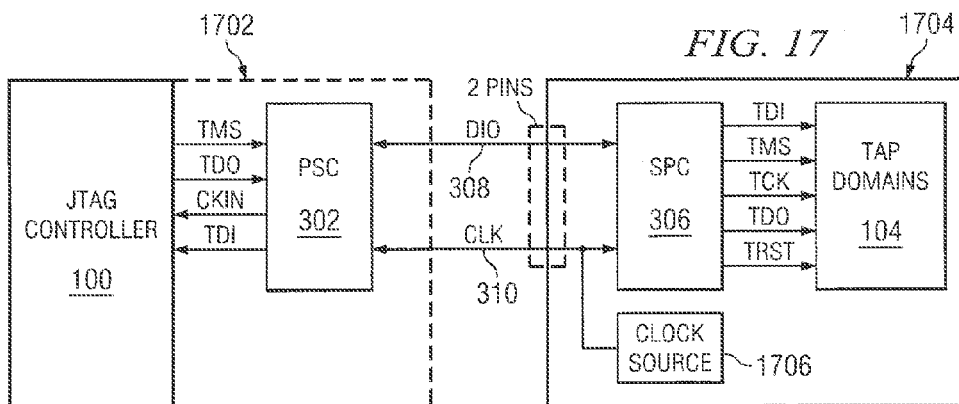
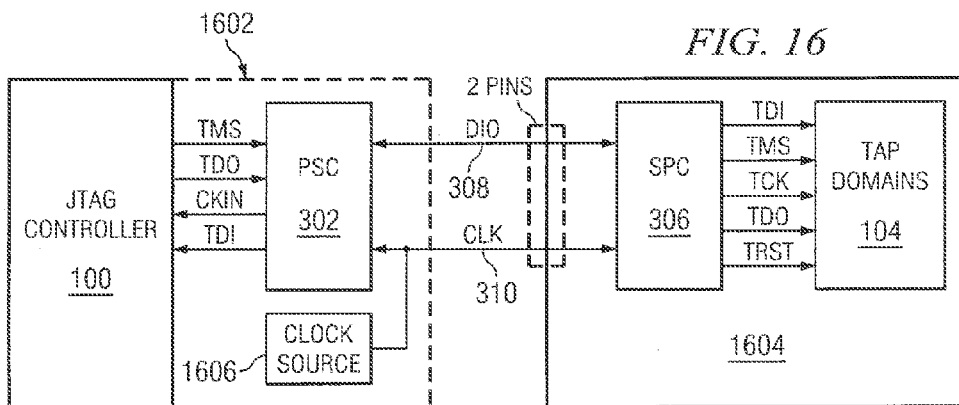
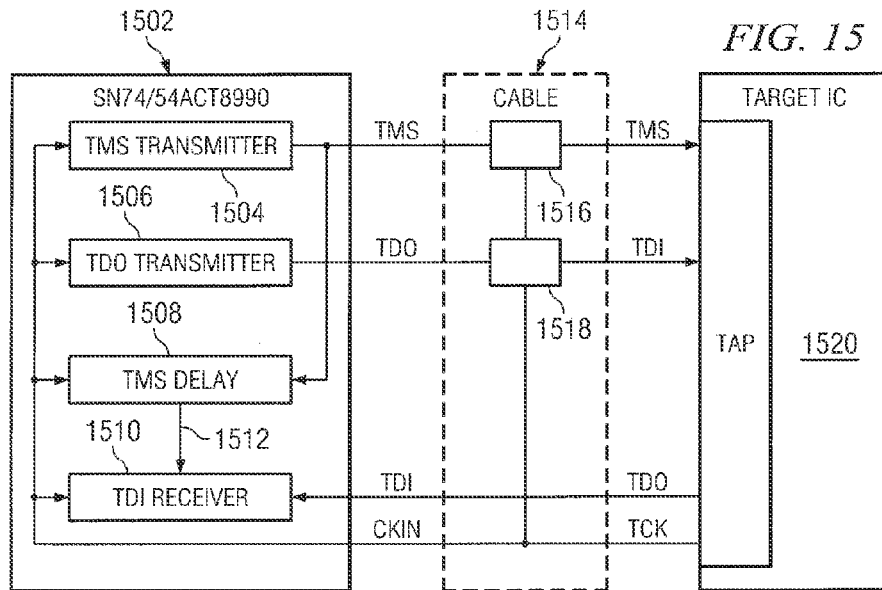
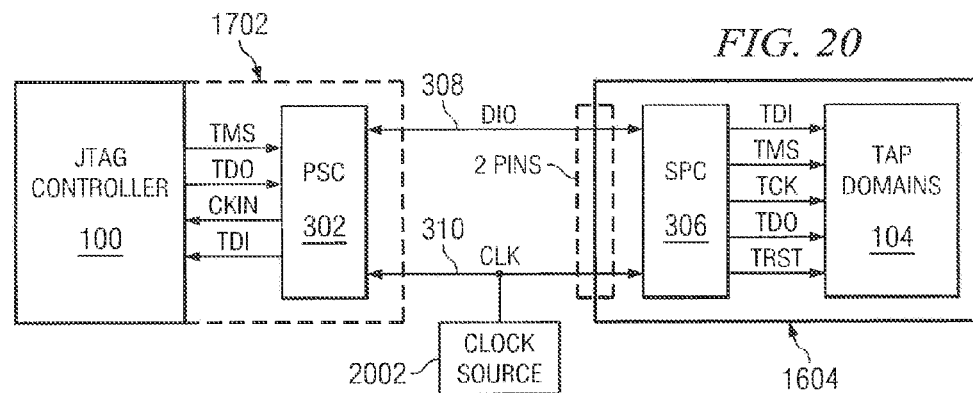
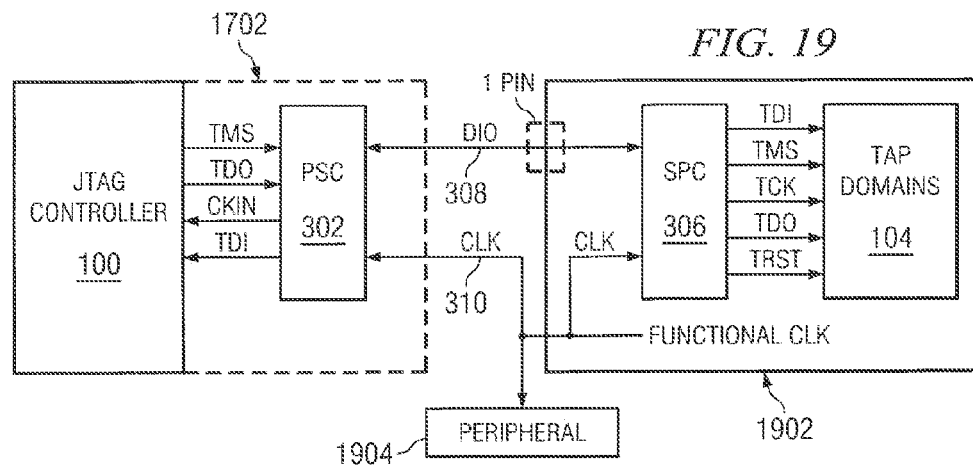
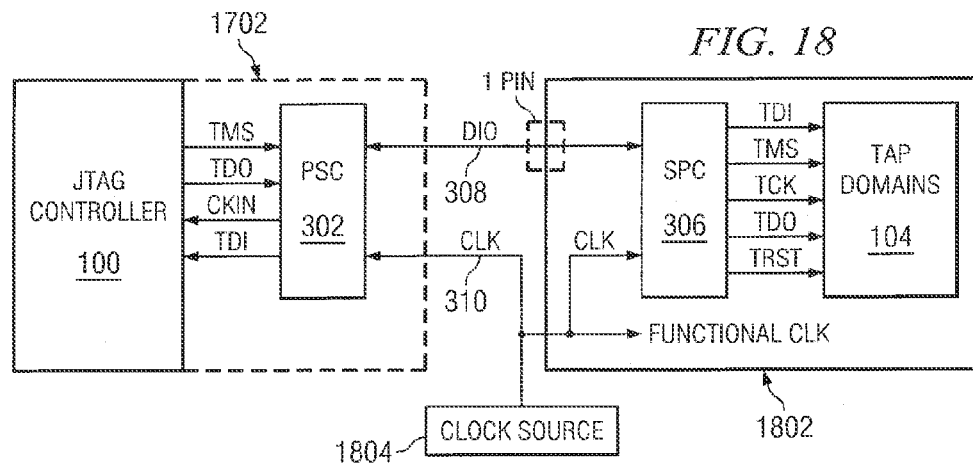


FIG. 14C







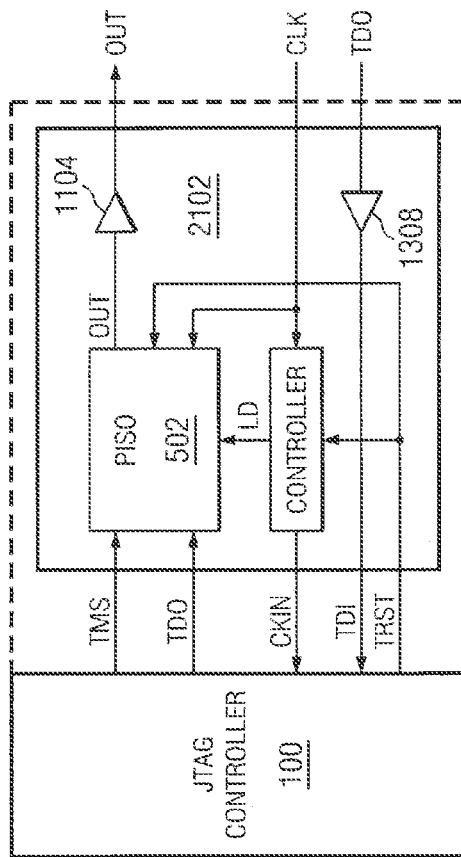


FIG. 21A

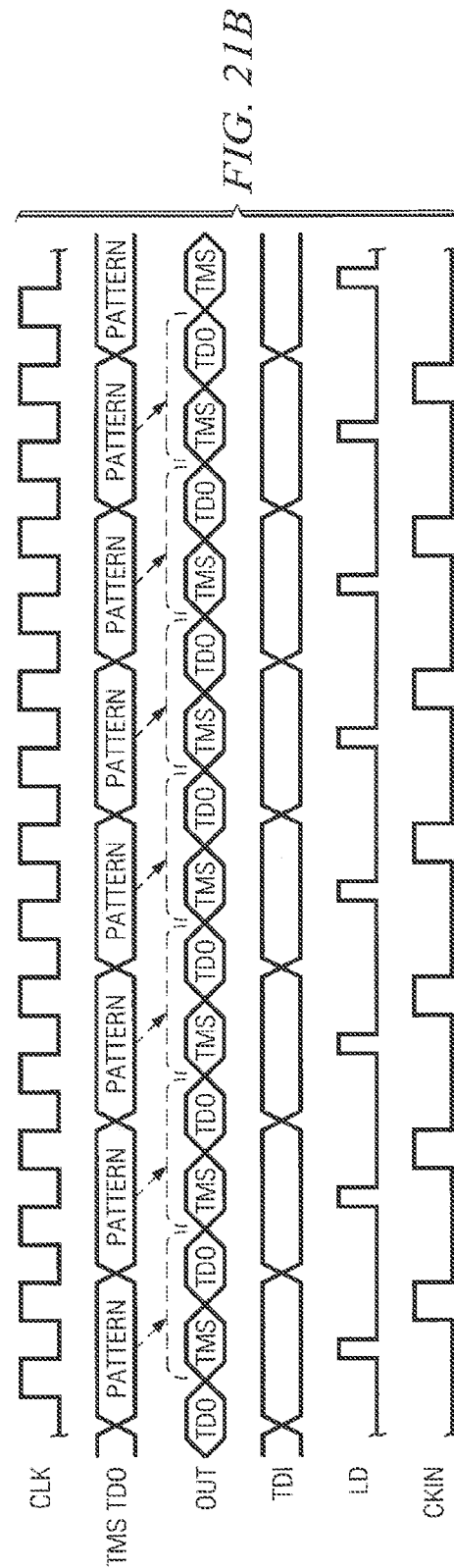
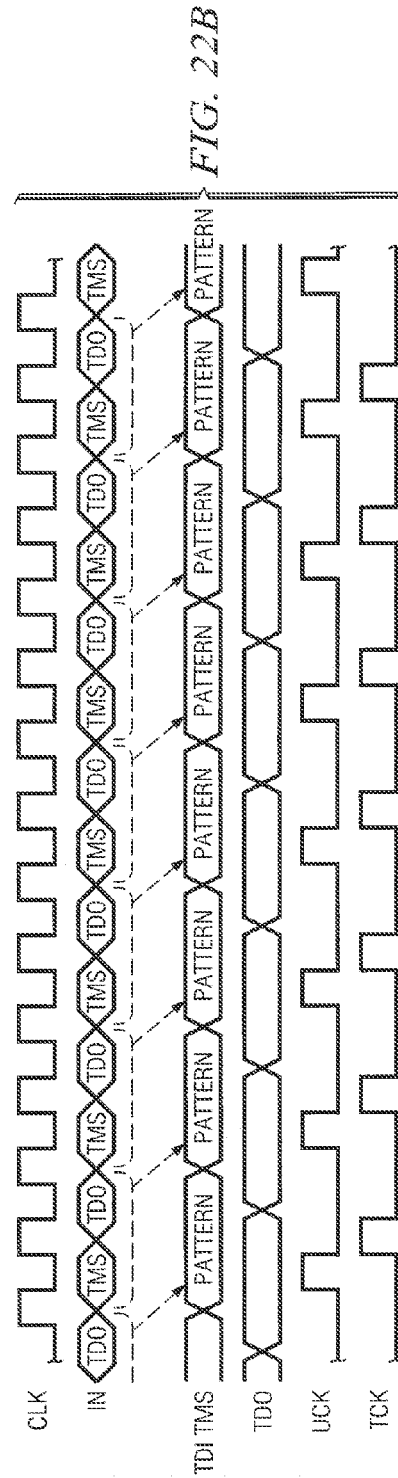
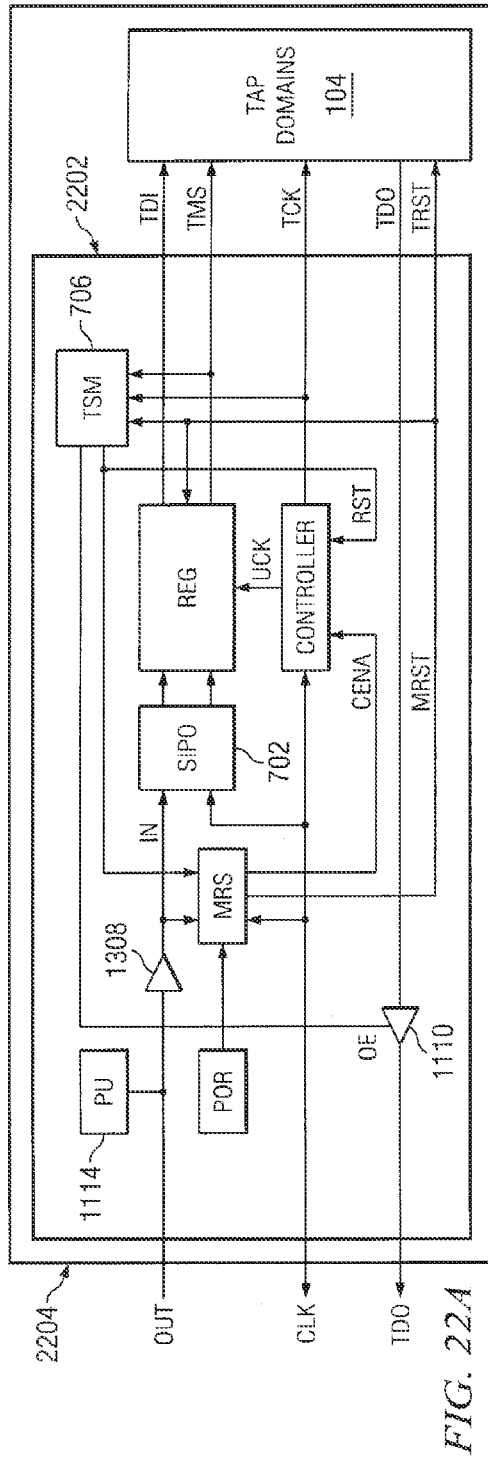


FIG. 21B



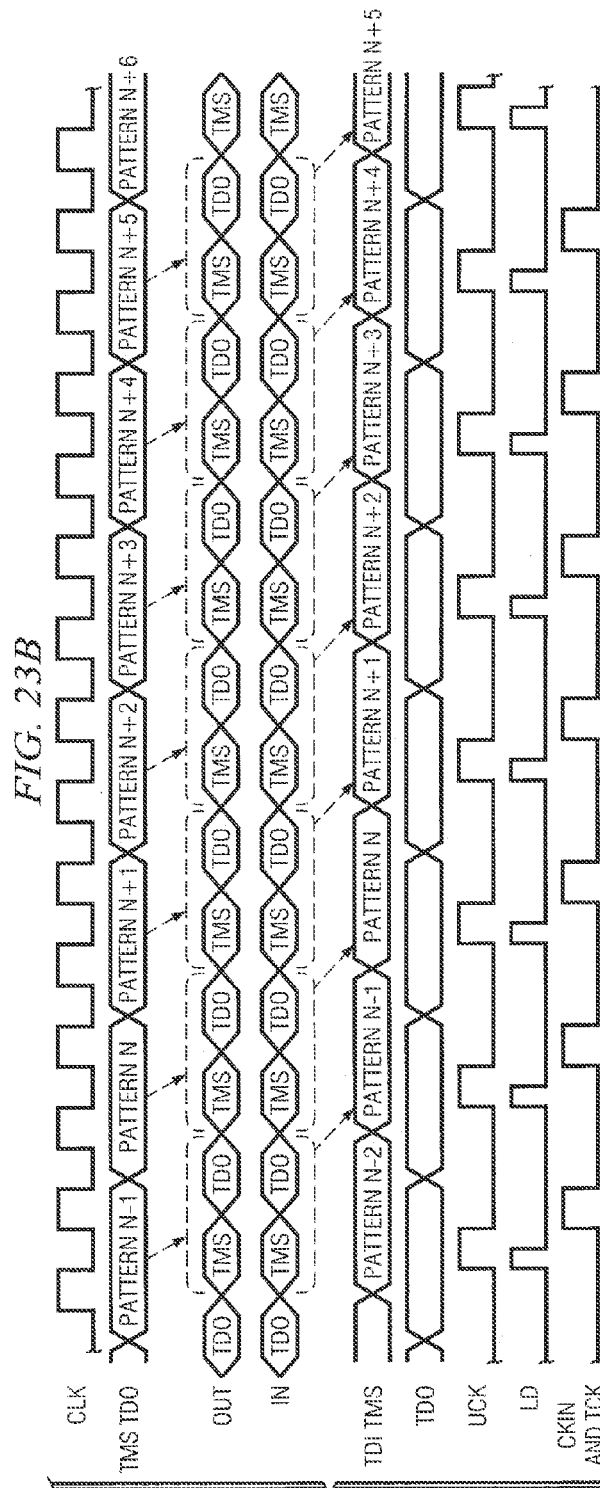
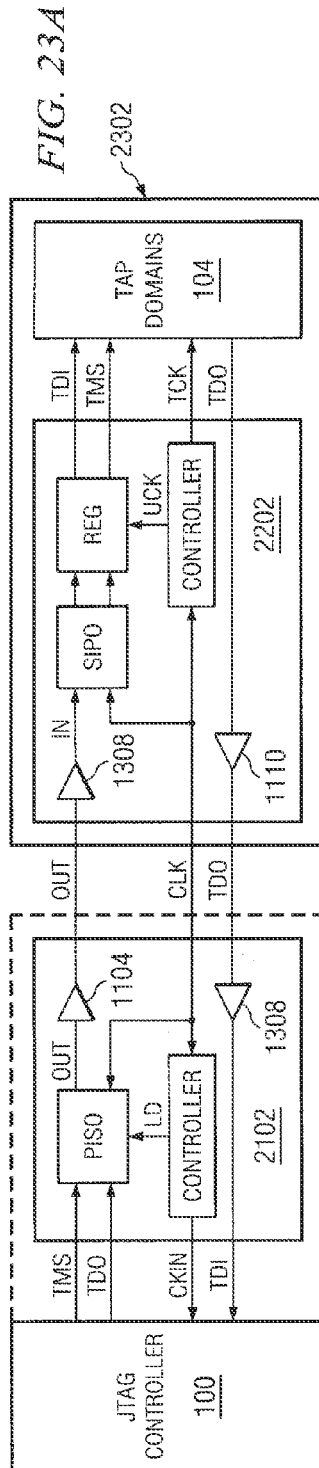


FIG. 24

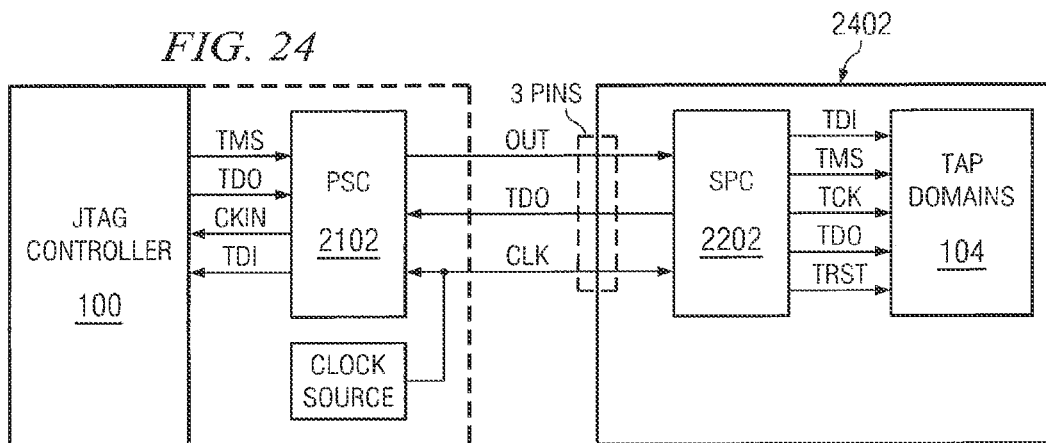


FIG. 25

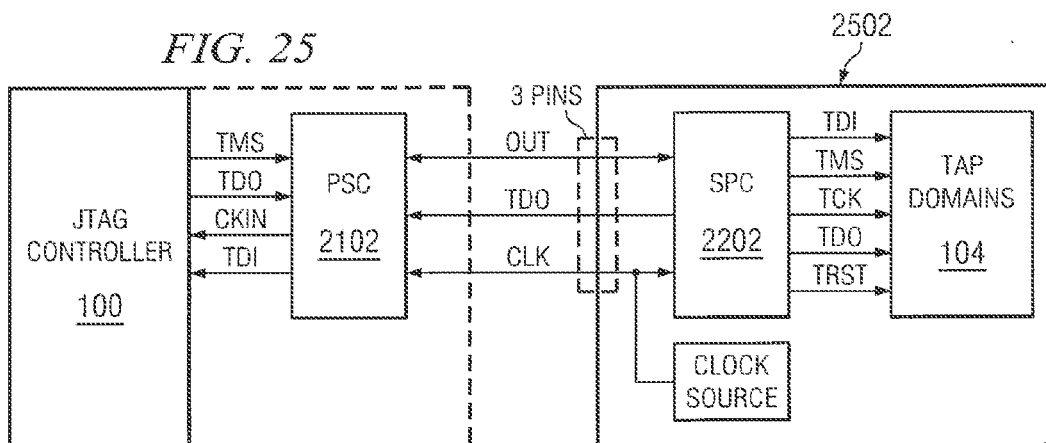


FIG. 26

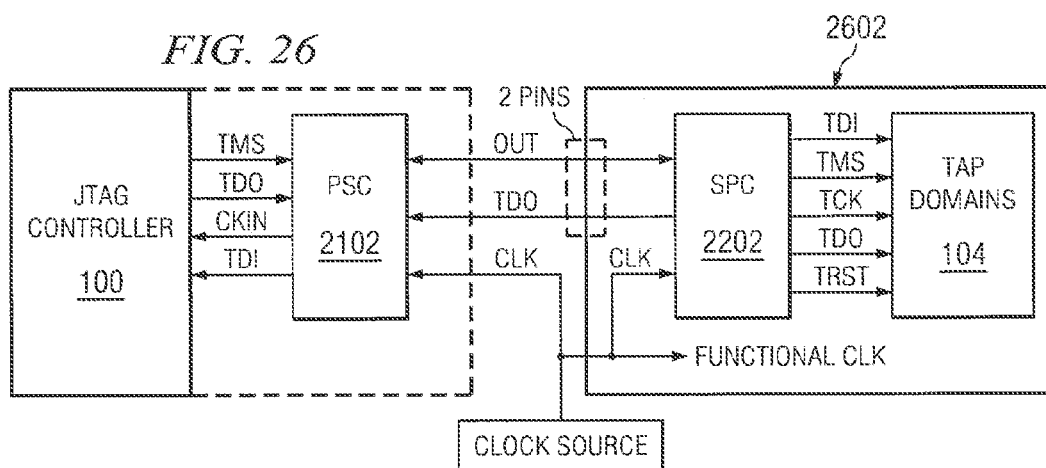


FIG. 27

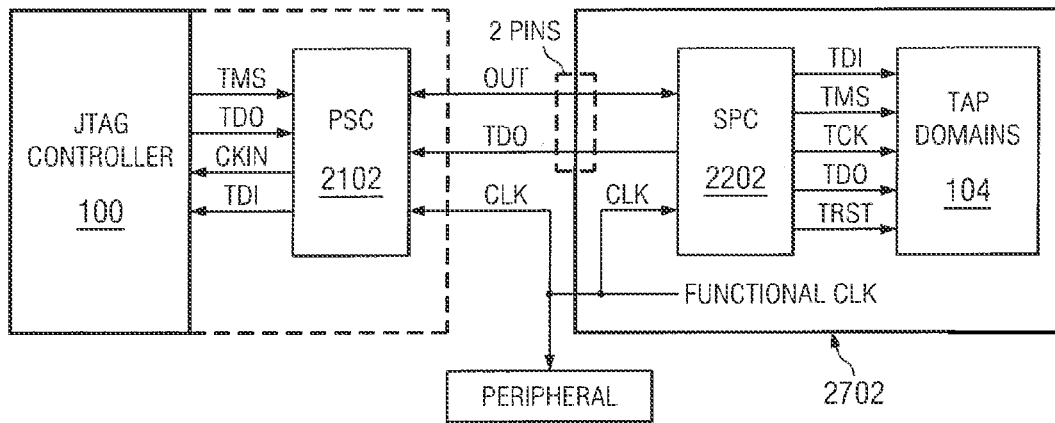
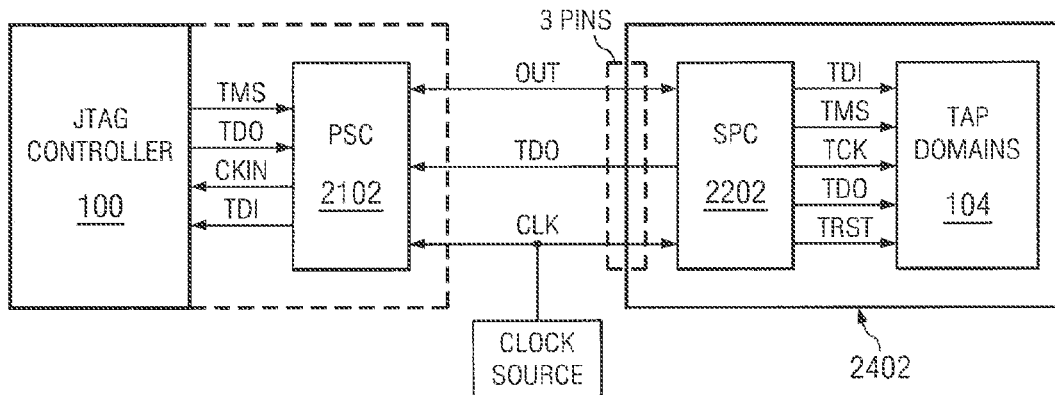


FIG. 28



OPERATING STATE MACHINE FROM RESET TO POLL IN TO RESET

CROSS-REFERENCE TO RELATED APPLICATIONS

This application is a divisional of application Ser. No. 13/855,970, filed Apr. 3, 2013, now U.S. Pat. No. 8,880,966, issued Nov. 4, 2014;

Which was a divisional of application Ser. No. 13/551,167, filed Jul. 17, 2012, now U.S. Pat. No. 8,433,962, granted Apr. 30, 2013;

Which was a divisional of application Ser. No. 13/197,000, filed Aug. 3, 2011, now U.S. Pat. No. 8,250,421, granted Aug. 21, 2012;

Which was a divisional of application Ser. No. 13/012,117, filed Jan. 24, 2011, now U.S. Pat. No. 8,020,059, granted Sep. 13, 2011;

Which was a divisional of application Ser. No. 12/887,672, filed Sep. 22, 2010, now U.S. Pat. No. 7,900,110, granted Mar. 1, 2011;

Which was a divisional of application Ser. No. 12/640,941, filed Dec. 17, 2009, now U.S. Pat. No. 7,823,037, granted Oct. 6, 2010;

Which was a divisional of application Ser. No. 12/182,605, filed Jul. 30, 2008, now U.S. Pat. No. 7,669,099, granted Feb. 23, 2010;

Which was a divisional of application Ser. No. 11/370,017, filed Mar. 7, 2006, now U.S. Pat. No. 7,421,633, granted Sep. 2, 2008;

And this application claims priority from Provisional Application No. 60/663,953, filed Mar. 21, 2005, and is related to the following patent applications or patents:

application Ser. No. 11/292,643, "Reduced Signal Interface Method and Apparatus," now U.S. Pat. No. 7,308,629, issued Dec. 11, 2007;

application Ser. No. 11/293,061, "Selectable Pin Count JTAG," now U.S. Pat. No. 7,328,387, issued Feb. 5, 2008;

application Ser. No. 11/258,315, "2 Pin Bus", now U.S. Pat. No. 8,412,853, issued Apr. 2, 2013;

application Ser. No. 08/918,872, U.S. Pat. No. 6,073,254 "Selectively Accessing IEEE 1149.1 Taps in a Multiple Tap Environment," issued Jun. 6, 2000; and

application Ser. No. 11/292,597, "Multiple Test Access Port Protocols Sharing Common Signals", now U.S. Pat. No. 7,571,366, issued Aug. 4, 2009.

BACKGROUND OF THE DISCLOSURE

This disclosure relates in general to IC signal interfaces and in particular to IC signal interfaces related to test, emulation, debug, and trace operations.

DESCRIPTION OF THE RELATED ART

FIG. 1 illustrates a conventional 5 wire JTAG interface **106** between an external JTAG controller **100** and Tap Domains **104** within a target IC **102**. Modern day ICs typically have a Tap Domain associated with the IC's JTAG boundary scan test operations and/or one or more Tap Domains associated with each one or more core circuits designed into the IC. The interface couples the TDO output of JTAG controller to the IC's TDI pin input, the TMS output of the JTAG controller to the IC's TMS pin input, the TCK output of the JTAG controller to the IC's TCK pin input, the TDI input of the JTAG controller to the IC's TDO pin output, and the TRST output of the JTAG controller to the IC's TRST pin input. The IC's TDI,

TDO, TMS, TCK, and TRST pins **108** are dedicated for interfacing to the JTAG controller and cannot be used functionally.

In response to the TMS and TCK signals, the Tap Domains of IC **102** communicates data to and from the JTAG controller via the TDO to TDI connections. A low output on the JTAG controller's TRST output causes the Tap Domains of IC **102** to enter a reset state. The JTAG controller receives a clock input (CKIN) from a clock source **110**. The CKIN input times the operation of the JTAG controller, which in turn times the operation of the Tap Domains in IC **102**. The JTAG controller can be used to perform test, emulation, debug, and trace operations in the target IC by accessing the embedded Tap Domains via the 5 wire interface. The arrangement between the JTAG controller and the target IC and its use in performing test, emulation, debug, and trace operations is well known in the industry.

FIG. 2 illustrates an alternate arrangement whereby a JTAG controller **200** is interfaced to a target IC **202** via the JTAG bus **108** and a Debug/Trace bus **204**. The JTAG controller **200** differs from the JTAG controller of FIG. 1 in that it includes additional circuitry and input/outputs for interfacing to the IC's Debug/Trace circuitry **204**. As in FIG. 1, the JTAG bus **108** is coupled to Tap Domains **104** within the IC via IC pins **108**. The Debug/Trace bus **204** is coupled to Debug/Trace circuitry **206** within the IC via N IC pins **208**. The JTAG bus is used to input commands and data that enable the Debug/Trace circuitry to perform debug and/or trace operations. The Debug/Trace bus signals can be used for a myriad of operations including but not limited to; (1) importing and/or exporting data between the JTAG controller **200** and Debug/Trace circuitry **206** during debug and/or trace operations, (2) operating as a communications bus between the JTAG controller **200** and Debug/Trace circuitry **206**, and (3) inputting and/or outputting trigger signals between the JTAG controller **200** and Debug/Trace circuitry **206** during debug and trace operations.

One of the key advantages of the debug/trace bus **204** is that it increases the data input/output bandwidth between the JTAG controller and target IC during debug/trace operation over what is possible using only the 5 wire JTAG bus **106**. For example, the data input/output bandwidth of the JTAG bus is limited to the amount of data that can flow between the JTAG controller and IC over the single TDO to TDI signal wire connections. Since the debug/trace bus can have N signal wire connections between the JTAG controller and IC (N), its data bandwidth can be much greater than the JTAG bus bandwidth. Increased data bandwidth between the JTAG controller and IC facilitates debug/trace operations such as; (1) monitoring real time code execution, (2) accessing embedded memories, (3) uploading/downloading code during program debug, and (4) triggered output trace functions.

With the current trend towards smaller IC packaging to allow more ICs to be placed on smaller assemblies used in mobile applications, such as cell phones and personal digital assistants, the number of IC pins is being reduced. It is therefore a benefit of the present disclosure to provide a reduced pin count interface on ICs for test, emulation, debug, and trace operations, as this will allow more IC pins to be available for functional purposes. While it is advantageous to reduce the pin counts of both the JTAG and Debug/Trace buses of FIGS. 1 and 2, this application focuses on reducing the JTAG bus pins of an IC.

In addition to reducing the JTAG bus pins of an IC, a second benefit of the present disclosure is to maintain a high communication bandwidth over the reduced JTAG pins. As will be shown, the present disclosure provides a data communication

bandwidth using the reduced JTAG pins that is equal to one half the data communication bandwidth using a full set of JTAG pins. For example, if the JTAG controller **100** can communicate data to and from Tap Domains **104** of FIG. **1** at 100 Mhz using the full JTAG bus **106**, a JTAG controller adapted according to the present disclosure can communicate data to and from Tap Domains **104** of an IC, also adapted according to the present disclosure at 50 Mhz.

One prior art technique, referenced herein, is called the J-Link System. The J-Link system provides a way to reduce the JTAG pins of an IC from the standard five pins to a reduced set of one or two pins. In a chart shown in the J-Link reference, it is seen that the J-Link interface provides a data communication bandwidth that is one sixth that of the conventional JTAG 5 pin interface. For example and as stated in the J-Link reference, if the standard 5 pin JTAG interface can operate at 48 Mhz, the J-Link interface operates at one sixth of the 48 Mhz frequency, or at 8 Mhz. In comparison and as will be shown herein, if the standard 5 pin JTAG interface can operate at 48 Mhz, the reduce pin approach of the present disclosure can operate at one half the 48 Mhz frequency, or at 24 Mhz. Thus the present disclosure provides a three times improvement in operating frequency over the referenced J-Link approach. The present disclosure is therefore capable of performing operations related to IC test, debug, emulation, and trace at three times the bandwidth of the referenced J-Link approach.

SUMMARY OF THE DISCLOSURE

The present disclosure provides a reduced pin interface for JTAG based test, emulation, debug, and trace transactions between a JTAG controller and a target IC.

DESCRIPTION OF THE VIEWS OF THE DRAWINGS

FIG. **1** illustrates a conventional 5 signal interface between a JTAG controller and target IC.

FIG. **2** illustrates a conventional JTAG controller interfaced to a target IC via a 5 signal JTAG bus and an N signal Debug/Trace bus.

FIG. **3** illustrates a JTAG controller interfaced to a target IC via a 2 signal JTAG bus according to the present disclosure.

FIGS. **4A-4C** illustrate various conventional Tap Domain arrangements within a target IC.

FIG. **5A** illustrates a circuit example of the parallel to serial controller (PSC) circuit of the present disclosure.

FIG. **5B** illustrates a timing diagram of the operation of the PSC circuit of FIG. **5A**.

FIG. **6A** illustrates a circuit example of the controller within the PSC circuit of FIG. **5A**.

FIG. **6B** illustrates a timing diagram of the operation of the controller of FIG. **6A**.

FIG. **7A** illustrates a circuit example of the serial to parallel controller (SPC) circuit of the present disclosure.

FIG. **7B** illustrates a timing diagram of the operation of the SPC circuit of FIG. **7A**.

FIG. **8A** illustrates a circuit example of the controller within the SPC circuit of FIG. **7A**.

FIG. **8B** illustrates a timing diagram of the operation of the controller of FIG. **8A**.

FIG. **9A** illustrates a circuit example of the master reset and synchronizer (MRS) circuit within the SPC circuit of FIG. **7A**.

FIG. **9B** illustrates a state diagram of the operation of the MRS circuit of FIG. **9A**.

FIG. **9C** illustrates a timing diagram of the operation of the MRS circuit of FIG. **9A**.

FIG. **10** illustrates the state diagram of the IEEE standard 1149.1 Tap controller state machine.

FIG. **11A** illustrates a circuit example of the input/output (I/O) circuits within the PSC and SPC circuits.

FIG. **11B** illustrates the signaling cases for the I/O circuits of FIG. **11A**.

FIG. **12** illustrates each signaling case of FIG. **11B** in more detail.

FIG. **13A** illustrates an example circuit for determining the appropriate TDI or IN signal output of the I/O circuits of FIG. **11**.

FIG. **13B** illustrates the truth table used for determining the appropriate TDI or IN signal output based on the voltage level of the data I/O (DIO) signal.

FIG. **14A** illustrates the 2 signal connection between the PSC of the JTAG controller and the SPC of the target IC according to the present disclosure.

FIG. **14B** illustrates a timing diagram of the operation of the PSC and SPC circuits of FIG. **14A** performing JTAG transactions between the JTAG controller and the Tap Domains of the target IC.

FIG. **14C** illustrates a timing diagram of the operation of the PSC and SPC circuits of FIG. **14A** performing a single bit data register scan between the JTAG controller and the Tap Domains of the target IC.

FIG. **15** illustrates a Texas Instruments SN74ACT8990 JTAG bus controller chip operating to compensate for cable delays.

FIG. **16** illustrates a 2 pin realization of the present disclosure whereby the CLK signal is driven by a clock source within the JTAG controller.

FIG. **17** illustrates a 2 pin realization of the present disclosure whereby the CLK signal is driven by an internal clock source of the target IC.

FIG. **18** illustrates a 1 pin realization of the present disclosure whereby the CLK signal is driven by an external clock source that functionally inputs to the target IC.

FIG. **19** illustrates a 1 pin realization of the present disclosure whereby the CLK signal is driven by an internal clock source of the target IC that functionally outputs from the IC.

FIG. **20** illustrates a 2 pin realization of the present disclosure whereby the CLK signal is driven by a clock source external of the JTAG controller and target IC.

FIG. **21A** illustrates an alternate circuit example of the parallel to serial controller (PSC) circuit of the present disclosure.

FIG. **21B** illustrates a timing diagram of the operation of the alternate PSC circuit of FIG. **21A**.

FIG. **22A** illustrates an alternate circuit example of the serial to parallel controller (SPC) circuit of the present disclosure.

FIG. **22B** illustrates a timing diagram of the operation of the SPC circuit of FIG. **22A**.

FIG. **23A** illustrates the 3 signal connection between the FIG. **21A** alternate PSC of the JTAG controller and the FIG. **22A** alternate SPC of the target IC of according to the present disclosure.

FIG. **23B** illustrates a timing diagram of the operation of the alternate FIG. **21A** PSC and FIG. **22A** SPC circuits performing JTAG transactions between the JTAG controller and the Tap Domains of the target IC.

FIG. **24** illustrates a 3 pin realization of the alternate version of the present disclosure whereby the CLK signal is driven by a clock source within the JTAG controller.

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FIG. 25 illustrates a 3 pin realization of the alternate version of the present disclosure whereby the CLK signal is driven by an internal clock source of the target IC.

FIG. 26 illustrates a 2 pin realization of the alternate version of the present disclosure whereby the CLK signal is driven by an external clock source that functionally inputs to the target IC.

FIG. 27 illustrates a 2 pin realization of the alternate version of the present disclosure whereby the CLK signal is driven by an internal clock source of the target IC that functionally outputs from the IC.

FIG. 28 illustrates a 3 pin realization of the alternate version of the present disclosure whereby the CLK signal is driven by a clock source external of the JTAG controller and target IC.

DETAILED DESCRIPTION

FIG. 3 illustrates the approach of the present disclosure to reduce the number of JTAG pins on an IC 300 and the number of JTAG bus signal connections between the IC 300 and JTAG controller 100. IC 300 and others illustrated in this disclosure could represent any type of integrated circuit including but not limited to, a microcontroller IC, a microprocessor IC, a digital signal processor IC, a mixed signal IC, an FPGA/CPLD IC, an ASIC, a system on chip IC, a peripheral IC, a ROM memory IC, or a RAM memory IC. In FIG. 3, the JTAG controller 100 is interfaced to a Parallel to Serial Controller (PSC) circuit 302 via TDO, TMS, CKIN, TDI, and TRST signals. The PSC 302 may be a separate circuit from the JTAG controller 100 or the PSC 302 and JTAG controller 100 may be integrated to form a new JTAG controller 304. The PSC 302 is interfaced to a Serial to Parallel Controller (SPC) circuit 306 in IC 300 via a bus comprising a data I/O (DIO) signal 308 and a clock (CLK) signal 310. The SPC 306 is interfaced to Tap Domains 104 in the IC 300 via TDI, TMS, TCK, TDO, and TRST signals. As will be described later in regard to FIGS. 16-20, the CLK signal 310 may be driven by a clock source associated with the JTAG controller 100, a clock source associated with the IC 300, or a clock source not associated with the JTAG controller 100 or IC 300.

FIG. 4A illustrates that the Tap Domain block 104 of IC 300 may consist of a single 1149.1 Tap architecture.

FIG. 4B illustrates that the Tap Domain block 104 of IC 300 may consist of a series of daisy-chained Tap architectures 1-N.

FIG. 4C illustrates that the Tap Domain block 104 of IC 300 may consist of a group of Tap architectures 1-N that may be selected individually or linked serially together in various daisy-chain arrangements using linking circuitry 400. An example of such linking circuitry 400 has been described in referenced U.S. Pat. No. 6,073,254.

FIG. 5A illustrates the PSC circuit 302 in more detail. The PSC consists of a controller 500, a parallel input serial output (PISO) register 502, and an input/output (I/O) circuit 504. PISO 502 inputs parallel TMS and TDO signals from the JTAG controller 100, the TRST signal from the JTAG controller 100, a load (LD) signal from controller 500, and outputs a serial output (OUT) signal to I/O circuit 504.

A simplified view of PISO 502 shows it containing two serially connected FFs 503 and 505. While the TRST signal from the JTAG controller is low, FFs 503 and 505 are asynchronously set to logic ones and do not respond to the CLK or LD inputs. This can be achieved, for example, by connecting the TRST signal to the Set input of FFs 503 and 505. The OUT signal is therefore high while TRST is low. When TRST goes high FFS 503 and 505 are enabled to respond to the CLK and

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LD inputs. In response to the LD input, FFs 503 and 505 asynchronously load TMS and TDO output from the JTAG controller, respectively. Once loaded, the FFs are shifted by CLK 310 to output TMS then TDO signals to I/O circuit 504 via the OUT signal.

Controller 500 inputs the CLK signal 310, the TRST signal from the JTAG controller 100. Controller 500 outputs the asynchronous LD signal to the PISO and a clock signal to the CKIN input of JTAG controller 100. While TRST is low, the controller is reset and does not respond to the CLK input. While reset the LD and CKIN outputs from the controller are low. When TRST goes high, the controller is enabled to respond to the CLK input and output LD and CKIN output signals.

I/O circuit 504 inputs the OUT signals from the PISO and outputs them on DIO 308. The I/O circuit 504 also inputs signals from DIO 308 and outputs them to the TDI input of JTAG controller 100. I/O circuit 504 is designed to allow the output of OUT signals to DIO 308 and the input of TDI signals from DIO 308 to occur simultaneously. The simultaneous input and output operation of I/O circuit 504 will be described in detail later in regard to FIGS. 11A, 11B, 12, 13A, and 13B.

The operation of PSC 302 (while TRST is high) is illustrated in the timing diagram of FIG. 5B. In response to the CLK input 310, the controller 500 operates to periodically output the LD signal to PISO 502 and the CKIN signal to JTAG controller 100. Also the CLK input 310 times the PISO 502 to shift data from its OUT output to the I/O circuit 504. The I/O circuit passes the OUT signal to the DIO 308 signal. The CKIN signal times the operation of the JTAG controller 100. The LD signal causes the PISO to asynchronously load the TMS and TDO signal pattern from JTAG controller 100. Once loaded, the TMS and TDO pattern is shifted out of the PISO to the I/O circuit in response to the CLK signal.

The following describes the PSC's repeating load and shift out sequence. A TMS and TDO pattern 510 is asynchronously loaded into the PISO in response to LD signal 512. CLK signal 514 shifts out the TMS signal portion of pattern 510 on the OUT output of the PISO, then CLK signal 516 shifts out the TDO signal portion of pattern 510 on the OUT output of the PISO. CKIN signal 518 advances the JTAG controller to output the next TMS and TDO pattern 520. LD signal 522 asynchronously loads the next TMS and TDO pattern 520 into the PISO. CLK signal 524 shifts out the TMS signal portion of pattern 520 on the OUT output of the PISO, then CLK signal 526 shifts out the TDO signal portion of pattern 520 on the OUT output of the PISO. CKIN signal 528 advances the JTAG controller to output the next TMS and TDO pattern 530 which is asynchronously loaded into the PISO by LD signal 532 and shifted out by CLK signals 534 and 536. The JTAG controller is advanced to output the next TMS and TDO pattern 540 during CKIN 538. The above described pattern load, pattern shift, and JTAG controller advancement process repeats as long as the CLK input 310 is active.

When the JTAG controller 100 receives a CKIN input it will output a new TMS and TDO signal pattern to PISO 502 and input the TDI signal from I/O circuit 504. The TMS signal output will control the Tap state machine of the target IC's Tap Domain 104 according to FIG. 10, the TDO signal will provide the TDI input signal to the target IC's Tap Domain (if in the Shift-DR/IR state), and the TDI input signal will input data to the JTAG controller from the target IC's Tap Domain (if in the Shift-DR/IR state).

FIG. 6A illustrates an example implementation of controller 500. Controller 500 consists of FF 600, FF 602, AND gates

604-608, and delay inverter **610**. While the TRST input from the JTAG controller **100** is low, FFs **600** and **602** are reset and the LD and CKIN outputs are low. When TRST goes high, FFs **600** and **602** are enabled to respond to the CLK input **310**. FF **600** toggles its load enable (LDENA) output during each rising edge of CLK input **310**. FF **602** stores the LDENA output of FF **600** at its clock enable (CKENA) output on each falling edge of CLK input **310**. AND gate **604** outputs a high when LDENA is high and CLK is low. AND Gate **606** and delay inverter **620** operate together to produce a high going pulse on the LD output whenever the output of AND gate **604** goes high.

The duration of the high going pulse on the LD signal is determined by the input to output signal delay through delay inverter **610**. The duration of the LD pulse should be long enough to asynchronously load the PISO with the TMS and TDO pattern but not long enough to interfere with the shifting operation of the PISO. For example, the high going LD pulse should return low for a sufficient amount of time prior to the next rising edge of the shifting CLK input so as to not interfere with the shift operation. The CKENA output of FF **602** enables AND gate **608** to pass the CLK signal **310** to the CKIN output. CKENA changes state on the falling edge of CLK **310** to allow a AND gate **608** to be enabled prior to the rising edge of CLK **310** to allow for good clock gating operation at the CKIN output.

The operation of controller **500** is illustrated in the timing diagram of FIG. 6B. In response to the CLK input **310**, the controller **500** operates to periodically output the LD and CKIN signals. As mentioned, the CKIN signal times the operation of the JTAG controller **100** and the LD signal causes the PISO to asynchronously load the TMS and TDO pattern from the JTAG controller **100**. On each rising edge of CLK **310** the LDENA output of FF **600** toggles its state. On each falling edge of CLK **310** the CKENA output of FF **602** is set to the state of the LDENA input to FF **602**. A LD pulse output occurs each time LDENA is high and the CLK goes low. A CKIN output occurs each time CKENA is high and the CLK is high.

FIG. 7A illustrates the SPC circuit **306** in more detail. The SPC consists of a controller **700**, a serial input parallel output (SIPO) register **702**, update register **704**, Tap state machine (TSM) **706**, master reset and synchronizer (MRS) circuit **708**, input/output (I/O) circuit **710**, and power on reset circuit (POR) **712**.

POR circuit **712** produces a temporary low active power on reset pulse whenever the target IC is first power up. This power on reset pulse is used to initialize the MRS circuit. When initialized, the MRS circuit **708** outputs a low on the master reset (MRST) signal to initialize other circuitry within the SPC **306** and to set TRST input of the connected Tap Domains **104** low. When TRST is low, the Tap Domains **104** are forced to the Test Logic Reset state. The Test Logic Reset state is a state of the 1149.1 Tap state machine and is shown in the Tap state machine diagram of FIG. 10. The POR circuit **712** may exist in the SPC **306** as shown or it may exist external to the SPC, i.e. as a separate circuit within the target IC. The function of the POR circuit to initialize the MRS circuit **708** may be achieved by other means. For example a reset pin of the IC may be substituted for the POR circuit **712** and used to initialize the MRS circuit **708**.

Controller **700** inputs the CLK signal **310**, a controller enable (CENA) signal from MRS **708**, a reset (RST) signal from TSM **706**. The controller outputs an update clock (UCK) to update register **704** and a TCK signal to Tap Domains **104** and TSM **706**. A detail description of controller **700** will be given in FIGS. 8A and 8B.

I/O circuit **710** inputs an output enable (OE) signal from TSM **706**. The OE signal is used to enable or disable the output drive of I/O circuit **710**. I/O circuit **710** inputs signals from DIO **308** and outputs them to SIPO **702** via the IN signal. If the OE is set to enable the output drive of I/O circuit **710**, TDO signals input from Tap Domains **104** are output on DIO. If the OE is set to disable the output drive of I/O circuit **710**, TDO signals are not output on DIO and the I/O circuit operates to only input DIO signals to SIPO **702** via the IN signal. I/O circuit **504** is designed to allow the output of TDO signals to DIO **308**, if enabled by OE, and the input of IN signals from DIO **308** to occur simultaneously. The simultaneous input and output operation of I/O circuit **710** will be described in detail later in regard to FIGS. 11A, 11B, 12, 13A, and 13B.

SIPO **702** inputs the serialized TMS and TDO signal patterns from the IN output of I/O circuit **710** in response to the CLK input **310** and outputs them to update register **704**. The update register **704** inputs the TDO and TMS outputs from the SIPO and outputs them as TDI and TMS signals to Tap Domains **104**. The update register also inputs the MRST signal from the MRS circuit **708**. While the MRST signal is active low the TDO and TMS outputs of the update register **704** are set high. While the MRST signal is inactive high the update register can respond to the update clock (UCK) signal from controller **700** to load TDO and TMS signals from the SIPO **702**.

A more detail view of SIPO **702** and update register **704** shows the SIPO containing two serially connected FFs **703** and **705**. In response to the CLK signal **310**, FFs **703** and **705** shift in the serialized TMS and TDO signals from the IN output of I/O circuit **710**. Once the TMS and TDO signals are shifted in they are transferred in parallel to FFs **707** and **709** in the update register **704** in response to the UCK signal where they are input to the TDI and TMS inputs of Tap Domains **104**. The update register serves to provide the current TDI and TMS input pattern to the Tap Domains **104** while the SIPO operates to serially input the next TDO and TMS pattern to be input to the Tap Domains **104**. As mentioned, the outputs of FFs **707** and **709** are asynchronously forced high in response to a low on the MRS signal, which results in highs being input to the TDI and TMS inputs of Tap Domain **104**. This can be achieved, for example, by connecting the MRS signal to the Set input of FFs **707** and **709**.

TSM circuit **706** inputs the TMS output from the update register, the TCK output of controller **700**, and the MRST output from MRS circuit **708**. TSM circuit **706** outputs a reset (RST) signal to controller **700** and MRS circuit **708**, and the OE signal to I/O circuit **710**. The TSM is simply the Tap state machine defined in IEEE standard 1149.1. The MRST input from MRS circuit **708** is connected to the standard "TRST" input of 1149.1 TSM, the TCK input from controller **700** is connected to the standard "TCK" input of the 1149.1 TSM, the TMS input from controller **700** is connected to the standard "TMS" input of the 1149.1 TSM, the RST output from TSM is connected to the standard "Reset*" output of the 1149.1 TSM, and the OE output of the TSM is connected to the standard "Enable" output of the 1149.1 TSM.

The TSM circuit is used by the present disclosure to allow the SPC to track the Tap states of the connected Tap Domains, especially the states that control the OE and RST outputs. The operation of the 1149.1 Tap state machine is defined in the 16 states shown in FIG. 10. While it is possible to actually use signals from the Tap state machine(s) of the connected Tap Domains **104** for tracking, instead of implementing a dedicated TSM circuit **706** in the SPC **306**, the required signals (OE and RST) may not always be available from the Tap Domains **104**. For example, connected Tap Domains **104** of

hard cores (i.e. cores that are fixed and cannot be modified) may not provide OE and RST output signal terminals for connection to the SPC's OE and RST terminals. Further, Tap Domains **104** having linking arrangements as shown in FIG. **4C** may present OE and RST signal switching complexities between the SPC **306** and linked Taps within Tap Domains **104**. Therefore, the SPC **306** preferably includes a TSM circuit **706** to insure simplicity in tracking the states of connected Tap Domains **104**.

MRS circuit **708** inputs the IN output of I/O circuit **710**, the CLK signal **310**, the RST signal from TSM **706**, and the power on reset output of POR circuit **712**. MRS circuit **708** outputs the MRST signal to Tap Domains **104**, TSM **706**, and update register **704** and the CENA signal to controller **700**. The purposes of the MRS circuit **708** are; (1) to maintain the SPC and connected Tap Domains **104** in a reset state when the target IC is operating normally in a system with no JTAG controller **100** and PSC **302** connected to the SPC's DIO **308** and CLK **310** signals, and (2) to allow synchronizing the operation of the SPC **306** to the operation of a JTAG controller **100** and PSC **302** when the JTAG controller and PSC are connected to the SPC's DIO and CLK signals. Synchronizing the operation of the SPC to the operation of the JTAG controller and PSC is important since it allows the serialized TMS and TDO patterns output from PSC to be correctly input as serialized TMS and TDO patterns to the SPC. A detail description of MRS circuit **708** will be given in regard to FIGS. **9A-9C**.

The operation of SPC **306** is illustrated in the timing diagram of FIG. **7B**. In response to the CLK input **310**, the controller **700** operates to periodically output the UCK signal to the update register **704** and the TCK signal to Tap Domains **104** and TSM **706**. Also the CLK input **310** times the SIPO **702** to shift in data from the IN output of the I/O circuit **710**. The I/O circuit passes DIO input signals to the IN output. The TCK signal times the operation of the Tap Domains **104**. The UCK signal causes the update register **704** to load the parallel TDO and TMS signal pattern output of the SIPO **702**. Once loaded, the TDO and TMS signal pattern is applied to the TDI and TMS inputs of Tap Domains **104**. The Tap Domains **104** respond to the TDI and TMS signal pattern in response to the TCK.

The following describes the SPC's repeating shift in and update sequence. A serial TMS and TDO bit stream **718** is shifted into SIPO **702** in response to CLK signals **720** and **722**. The shifted in TMS and TDO signals form a parallel TDO and TMS output pattern **724** from SIPO **702** that is clocked into to the update register **704** in response to UCK signal **726**. The TDO and TMS pattern **724** in the update register **704** is applied to the TDI and TMS inputs of Tap Domains **104**. TCK signal **728** clocks the Tap Domains **104** to respond to the TDI and TMS pattern **724** from update register **704**. The next serial TMS and TDO bit stream **730** is shifted into SIPO **702** in response to CLK signals **732** and **734**. The shifted in TMS and TDO signals form a parallel TDO and TMS output pattern **736** from SIPO **702** that is clocked into to the update register **704** in response to UCK signal **738**. The TDO and TMS pattern **738** in the update register **704** is applied to the TDI and TMS inputs of Tap Domains **104**. TCK signal **740** clocks the Tap Domains **104** to respond to the TDI and TMS pattern **730** from update register **704**. The above described serial pattern shift in, parallel pattern update, and Tap Domain clock operation repeats as long as the CLK input **310** is active.

When the Tap Domain **104** receives a TCK input, the Tap state machine of the Tap Domain responds to the TMS input to perform state transitions as seen in FIG. **10**. Also the Tap

Domain **104** will input data from its TDI input and output data on its TDO output in response to a TCK input, if the Tap state machine is in the Shift-DR/IR state of FIG. **10**.

FIG. **8A** illustrates an example implementation of controller **700**. Controller **700** consists of FF **800**, FF **802**, AND gates **804** and **806**, and OR gate **808**. FF **800** toggles its update enable (UPENA) output during each rising edge of CLK **310**. FF **802** stores the UPENA output of FF **800** at its clock enable (CKENA) output on each falling edge of CLK **310**. AND gate **804** outputs a high on its UCK output when UPENA is high, CLK is low, and the controller reset (CRST) output of OR gate **808** is high. AND gate **806** is gated on to pass its CLK **310** input to its TCK output whenever CKENA and CRST are high, otherwise the TCK output is forced low. OR gate **808** outputs a high on CRST whenever the CENA input from CS circuit **708** is high and/or the RST input from TSM **706** is high, otherwise CRST outputs a low. CKENA changes state on the falling edge of CLK **310** to allow AND gate **806** to be enabled prior to the rising edge of CLK **310** to allow for good clock gating operation at the TCK output.

The operation of controller **700** is illustrated in the timing diagram of FIG. **8B**. While the CRST output of OR gate **808** is high, the controller **700** operates to periodically output the UCK and TCK signals in response to the CLK input **310**. As mentioned, the TCK signal times the operation of the Tap Domains **104** and the UCK signal causes the update register to load the parallel TDO and TMS pattern from SIPO **702**. On each rising edge of CLK **310** the update enable (UPENA) output of FF **800** toggles its state. On each falling edge of CLK **310** the CKENA output of FF **802** is set to the state of the UPENA input to FF **802**. An UCK output occurs each time LDENA is high and the CLK goes low. A CKIN output occurs each time CKENA is high and the CLK is high. If CENA and RST are both low, the CRST output of OR gate **808** will be low to reset controller **700**. While CRST is low, the UPENA output of FF **800** is set high, the CKENA output of FF **802** is set low, the UCK output of AND gate **804** is set low, and the TCK output of AND gate **806** is set low.

FIG. **9A** illustrates an example implementation of the MRS circuit **708**. MRS circuit **708** consists of a state machine **900** and a FF **902**. The state machine **900** operates on the rising edge of CLK **310** and FF **902** operates on the falling edge of CLK **310**. The state machine **900** inputs the IN signal from I/O circuit **710**, the RST signal from TSM **706**, a clock signal from CLK **310**, and a power on reset signal from POR **712**. The state machine **900** outputs the previously mentioned MRST signal and a controller enable (CE) signal. The CE signal is connected to the D input of FF **902**. The Q output of FF **902** drives the previously mentioned CENA signal. The reset input of the FF **902** is connected to the power on reset output of POR **712**.

As previously mentioned the purposes of the MRS circuit **708** are to maintain the SPC and Tap Domains in a reset condition when the SPC's DIO **308** signal is not externally driven and to synchronize the operation of the SPC with an external circuit driving the SPC's DIO **308** signal.

The operation of state machine **900** is shown in the state diagram of FIG. **9B**. In response to a low active power on reset input from POR **712** or in response to the RST output of TSM **706** going low, the state machine **900** will enter "Set MRST Low & Poll IN" state **904**. In state **904** the state machine will output a low on the MRST output signal. The state machine will remain in state **904** while the IN input from I/O circuit **710** is high. The state machine will transition to "Poll IN" state **906** if the IN input goes low. The MRST output remains low in state **906**. The state machine will return to state **904** from state **906** if the IN input goes high, otherwise the state

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machine will transition from state 906 to “Poll IN” state 908. The MRST output remains low in state 908. The state machine will return to state 904 from state 908 if the IN input goes low, otherwise the state machine will transition from state 908 to “Poll IN” state 910. The MRST output remains low in state 910. The state machine will return to state 904 from state 910 if the IN input goes low, otherwise the state machine will transition from state 910 to “Set MRST & CE High” state 912.

In state 912, the state machine sets the MRST and CE signals high. On the falling edge of CLK 310, FF 902 clocks in the high CE output from state machine 900 which sets the CENA output of FF 902 high. The state machine will remain in state 912 while the RST input is low. When the RST input goes high, the state machine will transition to the “Set CE Low” state 914. In state 914, the state machine sets the CE signal low. On the falling edge of CLK 310, FF 902 clocks in the low CE output from state machine 900 which sets the CENA output of FF 902 low. The state machine will remain in state 914 while the RST input is high and will transition to state 904 when the RST input goes low.

The state machine is designed to enter state 904 when it receives a power on reset input from POR 712 or a low input on the RST output of TSM 706. The state machine will remain in state 904 as long as the IN input from I/O circuit 710 is high. As will be described later in regard to FIG. 11A, I/O circuit is designed to output a high on the IN signal when the state machine outputs a low on the MRST signal and if the DIO input 308 to I/O circuit 710 is not being externally driven. The high on the IN signal maintains the state machine 900 in state 904 which maintains a low on the state machine MRST output. While MRST is low, SPC 306 circuitry and Tap Domains 104 are held in an inactive reset state that cannot interfere with the normal operation of the target IC.

When the JTAG controller 100 and PSC circuit 302 of FIG. 5A are first connected to the DIO signal of the target IC’s SPC circuit 306 of FIG. 7A, the operation of the PSC and SPC circuits need to be synchronized such that the serialized TMS and TDO patterns from the PSC are correctly input as serialized TMS and TDO patterns to the SPC. The states within section 916 of the state diagram of FIG. 9B provide one example of how this required synchronization step may be achieved. A timing diagram depicting this synchronization process is shown in FIG. 9C.

Time reference 918 of FIG. 9C indicates a time period where the PSC 302 is not connected to SPC 306, i.e. DIO 308 is not being externally driven. The circuitry in the SPC 306 and Tap Domains 104 of the target IC have been initialized as previously described and the state machine 900 is in state 904 polling the high output of the IN signal and outputting a low on the MRST output. Time 918 could be a time where the target IC in which the SPC 306 and Tap Domains 104 reside is operating normally in a system and the SPC’s DIO signal is not being externally driven to perform test, emulation, debug, and/or trace operations. In this timing example it is assumed that CLK signal 310 is being actively driven by a clock source within the target IC. Thus state machine 900 state 904 is polling the high logic level of the IN signal during each rising edge of the active CLK signal 310. It is worth noting that if the IN signal were to temporarily go low during a CLK cycle input for some unknown reason, the state machine would return to state 904 via state 906. Further, the state machine would return to state 904 from states 908 and 910 in response to the IN signal having other temporarily low and high signal sequences for some unknown reason.

Time reference 920 of FIG. 9C indicates a time period where the PSC 302 has been externally connected to the SPC

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306 via the DIO 308 and CLK 310 signals. During the physical connection process there may be undesirable temporary signaling sequence on DIO 308 due to the electrical connection being formed between the PSC and SPC. These temporary signal sequences could prevent the successful synchronization between the PSC and SPC. The state transition mapping in section 916 of FIG. 9B is provided to filter out the following three types of temporary signal sequences on the DIO so that they do not affect the synchronization process between PSC and SPC.

(1) As seen in the state diagram, a temporary DIO signal sequence of 1-0-1 during the connection process would cause the state machine to transition from state 904 to state 906 and back to state 904. Thus this temporary DIO connection sequence is prevented from affecting the synchronization process.

(2) As seen in the state diagram, a temporary DIO signal sequence of 1-0-0-0-1 during the connection process would cause the state machine to transition from state 904 to state 906 to state 908 and back to state 904. Thus this temporary DIO connection sequence is prevented from affecting the synchronization process.

(3) As seen in the state diagram, a temporary DIO signal sequence of 1-0-0-1-0-1 during the connection process would cause the state machine to transition from state 904 to state 906 to state 908 to state 910 and back to state 904. Thus this temporary DIO connection sequence is prevented from affecting the synchronization process.

It should be understood that while the example state machine has been designed to filter out the above three types of temporary DIO sequences, it could be designed to filter out a greater number of DIO sequences if desired.

Time reference 922 of FIG. 9C indicates the start of a time period where the connection between the PSC 302 and SPC 306 has been made and the state machine is in state 904 with the IN signal driven high by DIO input from the connect PSC 302. The PSC 302 begins the synchronization process by serially inputting a pattern of two logic 0’s 924 on the SPC’s IN signal via DIO 308, which causes the state machine 900 to transition from state 904 to state 906 to state 908. As seen in FIG. 5A, the PSC outputs the two logic 0’s by loading the PISO 502 with a TMS value of 0 and a TDO value of 0 using the LD signal, then shifting the PISO to output the two logic 0’s using the CLK signal 310. Next the PSC 302 serially inputs a pattern of two logic 1’s 926 on the SPC’s IN signal via DIO 308, which causes the state machine 900 to transition from state 908 to state 910 to state 912. Again as seen in FIG. 5A, the PSC outputs the two logic 1’s by loading the PISO 502 with a TMS value of 1 and a TDO value of 1 using the LD signal, then shifting the PISO to output the two logic 1’s using the CLK signal 310. As seen, the state machine 900 can only transition from state 904 to state 912 in response to the exact input of a serial pattern of two logic 0’s followed by a serial pattern of two logic 1’s.

As seen in the timing diagram, the MRST and CE signal outputs of state machine 900 are set high in state 912 at time 925. MRST going high removes the reset condition from Tap Domains 104, TSM 706, and update register 704. CE going high causes FF 902 to set CENA high at time 927. When CENA goes high, the CRST signal of controller 700 is set high which enables the controller 700 to start outputting UCK and TCK signals at time 923. The first UCK signal at time 923 loads the two logic 1’s of pattern 926 into update register 704. The enabling of the SPC’s controller 700 at time 923 occurs such that the UCK and TCK signals of the SPC’s controller 700 are synchronized with the LD and CKIN signals of the PSC’s controller 500, respectively. By synchronizing the

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UCK signal with the LD signal and the TCK signal with the CKIN signal the SPC 306 can correctly receive subsequent serialized two bit patterns from PSC 302 via DIO 308. For example, when the PISO 502 is shifting out a two bit pattern the SIPO 702 is shifting in the two bit pattern, and when the PISO 502 is loading the next two bit pattern to be shifted the SIPO 702 is updating the current two bit pattern to the update register 704. The synchronized operation of the UCK and LD signals and the TCK and CKIN signals will be seen more clearly in regard to the description of FIG. 14A.

While state machine 900 of the present disclosure has been designed to use a sequence of two serialized two bit patterns 924 and 926 for synchronization, it could be designed to use a longer sequence of serialized two bit patterns for synchronization if desired. Using a longer sequence of two bit patterns would further reduce the possibility of synchronization failure between the PSC and SPC due to the previously mentioned connection process during time 920. Also a longer synchronization pattern sequence would improve the state machine's 900 ability to return to state 904, when DIO is not externally driven, in the event unexpected signaling were to occur on the state machine's IN input. While the example two bit patterns 924 and 926 used two 0's and two 1's respectively, the two bits of a pattern may use any desired or necessary combinations of 0's and 1's as well. The TMS portion of the last two bit pattern of a pattern sequence will be the first TMS input the Tap Domains 104 and TSM circuit 706 respond to. In the FIG. 9C example, the TMS portion of pattern 926 was set to logic 1 to cause the Tap Domains 104 and TSM circuit 706 to remain in the TLR state following synchronization. If the TMS portion of pattern 926 had been set to logic 0, the Tap Domains 104 and TSM circuit 706 would have transitioned to the RTI state following synchronization.

Following the above described PSC and SPC synchronization process, the PSC may begin inputting serialized TDO and TMS patterns to the SPC to scan JTAG instructions or data into the Tap Domains 104. The following example describes the PSC inputting serialized TDO and TMS patterns to the SPC to cause the Tap Domains 104 to perform an instruction scan operation according to the Tap state diagram of FIG. 10.

The SPC inputs a first serialized TDO (X) and TMS (0) pattern 928 from the PSC which is input to SIPO 702 and applied to the TDI and TMS input Tap Domains 104 and the TMS input of TSM 706 via update register 704 during UCK 929. The X in the TDO portion of the pattern indicates that TDO is a "don't care" signal. This first TDI and TMS pattern input to Tap Domains 104 and TSM 706 causes the Tap Domains and TSM to transition from the Test Logic Reset (TLR) state to the Run Test/Idle (RTI) state (FIG. 10) in response to TCK 942. On the falling edge of TCK 942 the TSM 706 sets its RST signal high to remove the reset condition at the input of OR gate 808 of controller 700. In response to RST going high, state machine 900 transitions to state 914 on the next rising edge of CLK 310. The state machine sets the CE output low in state 914 which causes FF 902 to output a low on CENA on the falling edge of CLK 310. State machine 900 will remain in state 914 while the RST signal is high. The SPC inputs a second serialized TDO (X) and TMS (1) pattern 930 from PSC which is input to SIPO 702 and applied to the TDI and TMS input Tap Domains 104 and the TMS input of TSM 706 via update register 704 during UCK 931. This second TDI and TMS pattern causes the Tap Domains 104 and TSM to transition from the RTI state to the Select-DR (SLD) state in response to TCK 944.

The SPC inputs a third serialized TDO (X) and TMS (1) pattern 932 from PSC which is input to SIPO 702 and applied

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to the TDI and TMS input Tap Domains 104 and the TMS input of TSM 706 via update register 704 during UCK 933. This third TDI and TMS pattern causes the Tap Domains 104 and TSM to transition from the SLD state to the Select-IR (SLI) state in response to TCK 946.

The SPC inputs a fourth serialized TDO (X) and TMS (0) pattern 934 from PSC which is input to SIPO 702 and applied to the TDI and TMS input Tap Domains 104 and the TMS input of TSM 706 via update register 704 during UCK 935. This fourth TDI and TMS pattern causes the Tap Domains 104 and TSM to transition from the SLI state to the Capture-IR (CPI) state in response to TCK 948.

The SPC inputs a fifth serialized TDO (0) and TMS (0) pattern 936 from PSC which is input to SIPO 702 and applied to the TDI and TMS input Tap Domains 104 and the TMS input of TSM 706 via update register 704 during UCK 937. This fifth TDI and TMS pattern causes the Tap Domains 104 and TSM to transition from the CPI state to the Shift-IR (SHI) state in response to TCK 950. When the TSM 706 transitions to the SHI state it's OE output is set to enable the output drive of I/O circuit 710 such that the first TDO output from the Tap Domains 104 can be output on DIO 308 to be input to the JTAG controller's TDI input via I/O circuit 504 of PSC controller 500. TSM 706 sets its OE to enable the output drive of I/O circuit 710 whenever the TSM (and Tap Domains) is in the Shift-IR or Shift-DR states of FIG. 10.

The SPC inputs a sixth serialized TDO (1) and TMS (0) pattern 938 from PSC which is input to SIPO 702 and applied to the TDI and TMS input Tap Domains 104 and the TMS input of TSM 706 via update register 704 during UCK 939. This sixth TDI and TMS pattern causes the Tap Domains 104 and TSM to remain in the SHI state in response to TCK 952. In pattern 938, TDO is shown set to a 1 to indicate that the first TDI input to be shifted into the Tap Domains 104 is a logic 1. On the rising edge of TCK 952 the first TDI input (1) of the sixth pattern 938 is shifted into the Tap Domains 104. Also the first TDO output from the Tap Domains 104 is input to the TDI input of the JTAG controller 100 on the rising edge of a CKIN input which is synchronized to TCK 952.

For as long as serialized patterns (940, 942, . . .) are input to cause the Tap Domains 104 (and TMS 706) to remain in the SHI state (i.e. TMS portion of the patterns=0), the TDI input portion of each pattern will be input to the Tap Domains 104 while TDO outputs from the Tap Domains will be input to the JTAG controller 100. When the shifting in and out of TDI and TDO is complete, the PSC will input serialized patterns with the TMS portion of the patterns set to move the Tap Domains 104 and TMS 706 from the Shift-IR state (SHI) to the Exit1-IR state, then to any other state according to the Tap state diagram of FIG. 10.

While the above process described performing an instruction scan operation between the JTAG controller and Tap Domains of the target IC, data scan operations may be similarly performed. Instruction and data scan operations using serialized TDI and TMS inputs from the JTAG controller and TDO outputs from the Tap Domains can be used to perform test, emulation, debug, trace, and/or other operations via the two signal DIO 308 and CLK 310 interface between the PSC and SPC.

When an operation is complete, the JTAG controller can output a string of serialized TDO and TMS patterns with the TMS portion of each pattern set to a logic one to cause the Tap Domains 104 and the TSM circuit 706 to transition into the Test Logic Reset state of FIG. 10. As seen in FIG. 10, the Tap state machine is designed to transition from any of its states to the Test Logic Reset state whenever it receives at least 5 logic high inputs on TMS. Therefore 5 serialized TDO and TMS

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patterns each with TMS high will cause the Tap Domains **104** and TSM **706** to enter the Test Logic Reset state.

When the TSM **706** enters the Test Logic Reset state it will set the RST output low which will reset the controller **700** and cause the MRS **708** state machine **900** to enter state **904**, which will result in the signal levels shown during time reference **918** of the timing diagram of FIG. **9C**. After the SPC circuitry has been reset by the RST signal the DIO and CLK connection between the PSC and SPC can be removed. During the PSC and SPC disconnect step, temporary signal glitching/bounce may occur on the DIO signal. The previously described state machine **900** states in section **916** of FIG. **9B** come into play once again to filter the IN input to the state machine such that the state machine remains in or returns to state **904** following any undesired temporary DIO signaling that may occur during the disconnect step. Following the disconnect step, the state machine will be in state **904** with the MRST output low, which maintains a reset condition on controller **700**, TSM **706**, and Tap Domains **104**.

FIG. **11A** illustrates an example of a JTAG controller **100** and PSC **302** arrangement **1100** interfaced the SPC **306** and Tap Domains **104** of target IC **300** via DIO **308** signal connections between I/O circuit **504** of arrangement **1100** and I/O circuit **710** of the target IC. For simplification, the CLK **310** signal that accompanies the DIO signal **308** is not shown in this example. Also for simplification and ease of description, the I/O circuits **504** and **710** are shown to exist outside the PSC **302** and SPC **306** respectively, instead of inside as previously shown in FIGS. **5A** and **7A**. I/O circuit **504** is coupled to the PSC **302** via the OUT signal and to the JTAG controller **100** via the TDI signal. I/O circuit **710** is coupled to the Tap Domains **104** via the TDO signal and to the SPC via the IN and OE signals.

I/O circuit **504** consists of an input circuit **1102**, an output buffer **1104**, and a resistor **1106**. The OUT signal is coupled to the input of buffer **1104** and to a first input of the input circuit **1102**. The output of the buffer **1104** is coupled to the DIO signal via resistor **1106**. The DIO signal is coupled to a second input of the input circuit **1102**. The output of the input circuit **1102** is coupled to the TDI input of the JTAG controller **100**.

I/O circuit **710** consists of an input circuit **1108**, an output buffer **1110**, a resistor **1112**, and a pull up (PU) circuit **1114**. The TDO signal is coupled to the input of buffer **1110** and to a first input of the input circuit **1108**. The output of the buffer **1110** is coupled to the DIO signal via resistor **1112**. The DIO signal is coupled to a second input of the input circuit **1108** and to the PU circuit **1114**. The output of the input circuit **1108** is coupled to the IN input of SPC **306**.

The PU circuit **1114** is used to set the DIO signal input to input circuit **1108** high when the DIO signal is not being driven by either buffer **1104** or **1110**. For example, when the JTAG controller and PSC arrangement **1100** is not connected to the DIO of the target IC and while the output drive of buffer **1110** of the target IC is disabled by the OE signal, the PU circuit **1114** will set the DIO signal high so that logic ones are input to the SPC **306** from the IN signal output of input circuit **1108** high. The high on the IN signal will cause the state machine **900** of MRS circuit **708** to remain in state **904** of FIG. **9B**, as previously described.

The output buffer **1104** of I/O circuit **504** and the output buffer **1110** of I/O circuit **710** will preferably be designed to have approximately the same current sink/source drive strength. Also the resistors **1106** and **1112** of I/O circuits **504** and **710** will have approximately the same resistance.

FIG. **11B** illustrates timing waveforms for the four cases A-D in which simultaneous data communication occurs

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between the I/O circuits **504** and **710** via DIO **308**. Each case A-D is indicated in the timing diagram by vertical dotted line boxes. FIG. **12** illustrates the current flow on the DIO signal wire during each of the four cases A-D. In these examples, the OE input to buffer **1110** is set to enable the buffer **1110** to drive the DIO signal.

Case A shows PSC **302** driving OUT low and Tap Domains **104** driving TDO low. As seen in Case A of FIG. **12**, with lows being output from both buffers **1104** and **1110** only a small amount of current flows on the DIO signal wire. This small current flow does not develop a significant voltage drop across resistors **1106** and **1112**. Thus the DIO signal input to the input circuits **1102** and **1108** will be easily detectable as being a low signal input. In response to this OUT and TDO output condition the DIO signal is driven low. With OUT and DIO low, the input circuit **1102** inputs a low on the TDI input to JTAG controller **100**. With TDO and DIO low, the input circuit **1108** inputs a low on the IN input to SPC **306**.

Case B shows PSC **302** driving OUT low and Tap Domains **104** driving TDO high. As seen in Case B of FIG. **12**, with a low being output from buffer **1104** and a high being output from buffer **1110** a larger current flows between the buffers on the DIO signal wire. The resistors **1106** and **1112** serve to limit this larger current flow and the voltage drops developed across them establish mid level voltage on the DIO wire that is easily detectable by the input circuits **1102** and **1108** from being either high or low. In response to this OUT and TDO output condition the DIO signal is driven to a mid voltage level. With OUT low and DIO at a mid voltage, the input circuit **1102** inputs a high on the TDI input to JTAG controller **100**. With TDO high and DIO at a mid voltage, the input circuit **1108** inputs a low on the IN input to SPC **306**.

Case C shows PSC **302** driving OUT high and Tap Domains **104** driving TDO low. As seen in Case C of FIG. **12**, with a high being output from buffer **1104** and a low being output from buffer **1110** a larger current flows between the buffers on the DIO signal wire. The resistors **1106** and **1112** serve to limit this larger current flow and the voltage drops developed across them establish mid level voltage on the DIO wire that is easily detectable by the input circuits **1102** and **1108** from being either high or low. In response to this OUT and TDO output condition the DIO signal is driven to a mid voltage level. With OUT high and DIO at a mid voltage, the input circuit **1102** inputs a low on the TDI input to JTAG controller **100**. With TDO low and DIO at a mid voltage, the input circuit **1108** inputs a high on the IN input to SPC **306**.

Case D shows PSC **302** driving OUT high and Tap Domains **104** driving TDO high. As seen in Case D of FIG. **12**, with highs being output from both buffers **1104** and **1110** only a small amount of current flows on the DIO signal wire. This small current flow does not develop a significant voltage drop across resistors **1106** and **1112**. Thus the DIO signal input to the input circuits **1102** and **1108** will be easily detectable as being a high signal input. In response to this OUT and TDO output condition the DIO signal is driven high. With OUT and DIO high, the input circuit **1102** inputs a high on the TDI input to JTAG controller **100**. With TDO and DIO high, the input circuit **1108** inputs a high on the IN input to SPC **306**.

FIG. **13A** illustrates one example of how to design an input circuit **1300** that can be used as either an input circuit **1102** or **1108**. The input circuit **1300** includes a voltage comparator circuit **1302**, a multiplexers **1304**, an inverter **1306**, and a buffer **1308**. The voltage comparator circuit **1302** inputs voltages from DIO and outputs digital control signals **S0** and **S1** to multiplexer **1304**. As seen, a first voltage (V) to ground (G) leg **1310** of voltage comparator circuit **1302** comprises a

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series P-channel transistor and a current source and a second voltage to ground leg **1312** comprises a series N-channel transistor and a current source. As seen, **S1** is connected at a point between the P-channel transistor and current source of the first leg **1310** and **S0** is connected at a point between the N-channel transistor and current source of the second leg **1312**. The gates of the transistors are connected to DIO to allow voltages on DIO to turn the transistors on and off.

The operation of the voltage comparator circuit **1302** and multiplexer **1304** is shown in the truth table of FIG. **13B** and described herein. If the voltage on DIO is low, the **S0** and **S1** outputs are set high, which causes the multiplexer **1304** to select its low input **1314** and output the low input on the TDI/IN (TDI for circuit **1102** and IN for circuit **1108**) signal via buffer **1308**. If the voltage on DIO is at a mid level, the **S0** is set low and the **S1** is set high, which causes the multiplexer **1304** to select its inverted OUT/TDO (OUT for circuit **1102** and TDO for circuit **1108**) input signal **1316** and output the inverted OUT/TDO signal to the TDI/IN signal via and buffer **1308**. If the voltage on DIO is high, the **S0** and **S1** outputs are set low, which causes the multiplexer **1304** to select its high input **1318** and output the high input to the TDI/IN signal via and buffer **1308**.

From the above description it is clear that the input circuit **1300** will; (1) input a low on TDI/IN if the DIO signal is low, (2) input a high on TDI/IN if the DIO signal is high, and (3) will input the inverse of OUT/TDO on TDI/IN if the DIO signal is at a mid level voltage between high and low.

Referring back to FIG. **11A** and in reference to the above description of input circuit **1300** it is clear that,

(1) If DIO is high, input circuits **1102** and **1108** will input highs to the JTAG controller **100** and SPC **306** respectively.

(2) If DIO is low, input circuits **1102** and **1108** will input lows to the JTAG controller **100** and SPC **306** respectively.

(3) If DIO is mid level and the OUT signal from PSC **302** is low, input circuit **1102** will know that the Tap Domain **104** is outputting a high on TDO to cause the mid level on DIO. Input circuit **1102** will therefore input a high to the TDI input of JTAG controller **100**.

(4) If DIO is mid level and the OUT signal from PSC **302** is high, input circuit **1102** will know that the Tap Domain **104** is outputting a low on TDO to cause the mid level on DIO. Input circuit **1102** will therefore input a low to the TDI input of JTAG controller **100**.

(5) If DIO is mid level and the TDO signal from Tap Domain **104** is low, input circuit **1108** will know that the PSC **302** is outputting a high on OUT to cause the mid level on DIO. Input circuit **1108** will therefore input a high to the IN input of SPC **306**; and

(6) If DIO is mid level and the TDO signal from Tap Domain **104** is high, input circuit **1108** will know that the PSC **302** is outputting a low on OUT to cause the mid level on DIO. Input circuit **1108** will therefore input a low to the IN input of SPC **306**.

FIG. **14A** shows a complete arrangement where the JTAG controller **100** and PSC **302** are connected to and are communicating with the SPC **306** and Tap Domains **104** of target IC **300** via the DIO **308** and CLK **310** signals. For simplification only the circuit elements of the PSC **302** and SPC **306** that are involved with the communication process are shown. The timing diagram of FIG. **14B** details the communication process.

In the timing diagram of FIG. **14B**, both the controllers **500** and **700** of PSC and SPC, respectively, have been synchronized as previously described and are actively operating their respective LD and CKIN and UCK and TCK signals in response to the CLK signal **310**. As seen and previously

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mentioned, the LD signal of the PSC operates synchronous with the UCK signal of the SPC, and the CKIN signal of the PSC operates synchronous with the TCK signal of the SPC. For simplification the CKIN and TCK signals are shown as one clock signal.

During LD signal **1402** TMS and TDO pattern N **1404** from JTAG controller **100** is loaded into PISO **502**. The TMS portion of the loaded pattern is shifted from PISO **502** to SIPO **702** during CLK **1406** and the TDO portion of the loaded pattern is shifted from PISO **502** to SIPO **702** during CLK **1408**. CKIN **1410** advances the JTAG controller to output the next TMS and TDO pattern N+1 **1412** and to input the TDO output **1415** from the Tap Domains (if in the Shift-DR or Shift-IR state). TCK **1410** causes the TAP Domains **104** to respond to the previously transmitted TDI and TMS input pattern N-1 **1414** input to the Tap Domains during UCK **1413**. Also during TCK **1410**, the Tap Domains will output the next TDO output to be input to the JTAG controller (if in the Shift-DR or Shift-IR state).

During LD signal **1418** TMS and TDO pattern N+1 **1412** from JTAG controller **100** is loaded into PISO **502**. The TMS portion of the loaded pattern is shifted from PISO **502** to SIPO **702** during CLK **1420** and the TDO portion of the loaded pattern is shifted from PISO **502** to SIPO **702** during CLK **1422**. CKIN **1424** advances the JTAG controller to output the next TMS and TDO pattern N+2 **1426** and to input the TDO output **1428** from the Tap Domains. TCK **1424** causes the TAP Domains **104** to respond to TDI and TMS input pattern N **1416** input to the Tap Domains during UCK **1413**. Also during TCK **1424**, the Tap Domains will output the next TDO output **1432** to be input to the JTAG controller.

The above described timing example of the communication between the JTAG controller **100** and Tap Domains **104**, via PSC and SPC, continues while a DIO and CLK connection exists between the PSC and SPC and while the CLK signal **310** is active.

FIG. **14C** illustrates a timing example of the arrangement of FIG. **14A** performing a single data register shift operation between the JTAG controller and Tap Domains. As seen the JTAG controller outputs a sequence of TMS and TDO patterns **1440-1454** that will control the Tap Domains to transition from the Run Test/Idle (RTI) state, to the Select-DR (SLD) state, to the Capture-DR (CPD) state, to the Select-DR (SLD) state, to the Exit1-DR (X1D) state, to the Update-DR (UPD) state, and back to the RTI state of FIG. **10**. This Tap state sequence will cause a one bit data register shift operation to occur between the JTAG controller and Tap Domains. The sequence of patterns **1440-1454** output from the JTAG controller is serialized by the PSC and de-serialized by the SPC to be input to the Tap Domains as TDI and TMS pattern sequences **1454-1468**. As seen the process of serializing and de-serializing the patterns causes TDI and TMS patterns input to the Tap Domains to lag behind the TMS and TDO patterns output from the JTAG controller.

If the JTAG controller were conventionally connected to the Tap Domains as seen in FIG. **1**, the TDO to TDI data shift operation between them would occur on the rising edge of the CKIN and TCK at time **1470**, i.e. when the Tap Domains transition from the Shift-DR (SFD) state to the Exit1-DR (X1D) state. However due to the pattern lag, the TDO to TDI data shift operation between them occurs on the rising edge of the CKIN and TCK at time **1472**. The shift in of the TDO data output from the JTAG controller to the TDI input of the Tap Domains is not effected by the pattern lag since the TDO data remains in the TDI and TMS pattern input to the Tap Domains following the serialization and de-serialization process and is clocked into the Tap Domains on the rising edge of TCK

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1472. However, the JTAG controller will not input the correct TDO output from the Tap Domains on the rising edge of CKIN 1470 since, due to the pattern lag, the correct TDO output (shown as dark filled) from the Tap Domains is not output from the Tap Domains until the falling edge of TCK 1470. Thus while TDO data from the JTAG controller is correctly input as TDI data to the Tap Domains, the TDO output from the Tap Domains is incorrectly input as TDI data to the JTAG controller.

JTAG controllers that are designed using Texas Instruments SN74/54ACT8990 JTAG bus controller chips can resolve the above mentioned pattern lag problem. The SN74/54ACT8990 JTAG bus controller chips were designed to operate with cabling between JTAG controllers and target ICs that can register the TMS and TDO outputs from the JTAG controller to the TMS and TDI inputs of the target IC.

FIG. 15 illustrates an arrangement whereby the ACT8990 JTAG controller chip 1502 is interfaced to a target IC 1520 via a cable 1514 that includes FFs 1516-1518 in the path between the ACT8990's TMS and TDO outputs and the target IC's TMS and TDI inputs. In this example the target IC sources the CKIN to the ACT8990 and also times the operation of FFs 1516 and 1518. As seen, the FFs 1516 and 1518 cause the TMS and TDI inputs to the target IC to lag the TMS and TDO output from the ACT8990 similar to the way the PSC and SPC circuits of FIG. 14A cause the TMS and TDI inputs to IC 300 to lag the TMS and TDO output of the JTAG controller 100 in FIG. 14A.

A simplified block diagram of the ACT 8990 shows it containing a circuit 1504 for transmitting the TMS signal, a circuit 1506 for transmitting the TDO signal, a circuit 1510 from receiving the TDI signal, and a circuit 1508 for delaying the TMS signal 1512 input to the TDI receiver circuit 1510. The TDI receiver circuit responds to the TMS signal 1512, as per the Tap state diagram of FIG. 10, to know when to input the TDI signal. In this example, all the circuits 1504-1510 are timed by the CKIN input from the TCK output of IC 1520.

If no FFs existed in the cable, i.e. TMS and TDO output of the ACT8990 were directly connected to TMS and TDI inputs of the target IC, the TMS delay circuit would be set to not delay the TMS signal input to the TDI receiver. In this case the TDI receiver 1510 operates in step with the Tap of the target IC 1520 such that TDI receiver 1510 inputs TDI data at the same time that the Tap of IC 1520 inputs TDI data.

If the FFs existed in the path as shown, the TMS delay circuit is set to delay the operation of the TDI receiver for one CKIN cycle to allow the operation of the TDI receiver to be synchronized with the operation of the Tap of IC 1520. By delaying the operation of the TDI receiver, the TDI receiver is made to operate in step with the delayed operation of the Tap of target IC 1520 such that TDI receiver 1510 inputs TDI data at the same time that the Tap of IC 1520 inputs TDI data.

While the delay circuit 1508 of the ACT8990 JTAG bus controller chip was originally designed to compensate for delays associated with cables, the present disclosure utilizes the delay circuit 1508 feature to compensate for the delay associated with the serialization and de-serialization operation of the PSC and SPC circuits in FIG. 14A.

For example, if the JTAG controller 100 of FIG. 14A used the ACT8990 chip to control the JTAG bus, the delay circuit 1508 of the ACT8990 could be set to delay the TDI input from the Tap Domains of IC 300 by one CKIN cycle such that the TDI input is correctly received on the rising edge of CKIN 1472, as shown in the timing diagram of FIG. 14C. Thus the previously mentioned lag problem, due to the serialization and de-serialization process of the PSC and SPC circuits, is remedied by using JTAG controllers 100 that incorporate the

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ACT8990 JTAG bus controller chip or other chips/circuits that can similarly delay the inputting of TDI data from the Tap Domains 104 of FIG. 14A.

FIG. 16 illustrates a first system example wherein a JTAG controller 100 and PSC 302 arrangement 1602 is coupled to the SPC 306 and Tap Domains 104 of a target IC 1604 via DIO 308 and CLK 310 signal wiring. In this example a clock source 1606 within arrangement 1602 is used to drive the CLK signal that times the operation of the PSC and SPC circuits. In this example the target IC 1604 requires two dedicated pins for the DIO and CLK signals.

FIG. 17 illustrates a second system example wherein a JTAG controller 100 and PSC 302 arrangement 1702 is coupled to the SPC 306 and Tap Domains 104 of a target IC 1704 via DIO 308 and CLK 310 signal wiring. In this example a clock source 1706 within target IC 1704 is used to drive the CLK signal that times the operation of the PSC and SPC circuits. In this example the target IC 1704 requires two dedicated pins for the DIO and CLK signals.

FIG. 18 illustrates a third system example wherein a JTAG controller 100 and PSC 302 arrangement 1702 is coupled to the SPC 306 and Tap Domains 104 of a target IC 1802 via a DIO 308 signal wire. In this example an external clock source 1804 used to input a functional clock to IC 1802 via a functionally required clock input pin. The external clock source also drives the CLK signal of PSC 302. Since the SPC 306 CLK input is connected to and driven by the IC's functional clock, a dedicated pin for the CLK signal 310 is not required on IC 1802. In this example the target IC 1802 requires only a dedicated pin for the DIO signal.

FIG. 19 illustrates a fourth system example wherein a JTAG controller 100 and PSC 302 arrangement 1702 is coupled to the SPC 306 and Tap Domains 104 of a target IC 1902 via a DIO 308 signal wire. In this example a functional clock is output from IC 1902 to drive the clock input of a peripheral circuit 1904 via a functionally required clock output pin. Internal to the IC 1902, the functional clock is connected to and drives the CLK input of SPC 306. External of the IC 1902, the functional clock is connected to and drives the CLK input of PSC 302. Since the PSC 302 CLK input is connected to the external functional clock, a dedicated pin for the CLK signal 310 is not required on IC 1902. In this example the target IC 1902 requires only a dedicated pin for the DIO signal.

FIG. 20 illustrates a fifth system example wherein a JTAG controller 100 and PSC 302 arrangement 1702 is coupled to the SPC 306 and Tap Domains 104 of a target IC 1604 via DIO 308 and CLK 310 signal wiring. In this example a clock source 2002 external of both arrangement 1702 and IC 1604 is used to drive the CLK signal that times the operation of the PSC and SPC circuits. In this example the target IC 1604 requires two dedicated pins for the DIO and CLK signals.

The above system examples of FIGS. 16-20 have shown various ways to interface the PSC and SPC circuits together such that at most the interface requires two dedicated IC pins for DIO and CLK and at least the interface only requires one dedicated pin for DIO. Thus the present disclosure is seen to require only one or two dedicated pins on the target IC.

The following Figures illustrate an alternate version of the present disclosure whereby the SPC 302 and PSC 306 circuits do not use I/O circuits 504 and 710, respectively.

FIG. 21A illustrates a JTAG controller 100 interfaced to an alternate PSC circuit 2102. The PSC circuit 2102 is identical to the PSC 302 of FIG. 5A with the exception that the I/O circuit 504 is not used in PSC circuit 2102. As seen, without the I/O circuit 504 the OUT output from PISO 502 is directly output from the PSC via output buffer 1104. Also as seen,

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without the I/O circuit **504** the TDO input goes directly to the TDI input of the JTAG controller **100** via an input buffer **1308**. As seen in FIG. **21B**, the operation timing of the alternate PSC **2102** and JTAG controller **100** is identical to the FIG. **5B** timing operation of the PSC **302** and JTAG controller **100** of FIG. **5A**.

FIG. **22A** illustrates an alternate SPC circuit **2202** interfaced to Tap Domains **104** of target IC **2204**. The SPC circuit **2202** is identical to the SPC **302** of FIG. **7A** with the exception that the I/O circuit **710** is not used in SPC circuit **2202**. As seen, without the I/O circuit **710** the OUT input to SPC **2202** is directly input to the MRS **708** and SIPO **702** circuits via a second input buffer **1308**. Also as seen, without the I/O circuit **710** the TDO output from Tap Domains **104** is directly output from SPC **2202** via 3-state buffer **1110**. Buffer **2206** is enabled by the OE signal from TSM **706**. The pull up (PU) element **1114** is connected to the IN signal to pull the IN signal high when it is not being externally driven for reasons previously mentioned. As seen in FIG. **22B**, the operation timing of the alternate SPC **2202** and Tap Domains **104** is identical to the FIG. **7B** timing operation of the SPC **302** and Tap Domains **104** of FIG. **7A**.

FIG. **23A** shows a complete arrangement where the JTAG controller **100** and alternate PSC **2102** are connected to and are communicating with the alternate SPC **2202** and Tap Domains **104** of target IC **2302** via the OUT, CLK, and TDO signals. For simplification only the circuit elements of the alternate PSC **2102** and SPC **2202** that are involved with the communication process are shown. As seen the OUT output from PSC **2102** is directly input to the IN input of the SPC **2202** and the TDO output from Tap Domains **104** is directly input to the TDI input of JTAG controller **100**. As seen in FIG. **23B**, the operation timing of the FIG. **23A** arrangement is identical to the FIG. **14B** timing operation of the FIG. **14A** arrangement.

FIG. **24** illustrates the previously described clocking arrangement of the FIG. **16** system. In FIG. **24**, alternate PSC **2102** is used instead of PSC **302** and alternate SPC **2202** is used instead of SPC **306**. As seen, the IC **2402** requires three dedicated pins for OUT, TDO, and CLK.

FIG. **25** illustrates the previously described clocking arrangement of FIG. **17** system. In FIG. **25**, alternate PSC **2102** is used instead of PSC **302** and alternate SPC **2202** is used instead of SPC **306**. As seen, the IC **2502** requires three dedicated pins for OUT, TDO, and CLK.

FIG. **26** illustrates the previously described clocking arrangement of FIG. **18** system. In FIG. **26**, alternate PSC **2102** is used instead of PSC **302** and alternate SPC **2202** is used instead of SPC **306**. As seen, the IC **2602** requires two dedicated pins for OUT and TDO.

FIG. **27** illustrates the previously described clocking arrangement of FIG. **19** system. In FIG. **27**, alternate PSC **2102** is used instead of PSC **302** and alternate SPC **2202** is used instead of SPC **306**. As seen, the IC **2702** requires two dedicated pins for OUT and TDO.

FIG. **28** illustrates the previously described clocking arrangement of FIG. **20** system. In FIG. **28**, alternate PSC **2102** is used instead of PSC **302** and alternate SPC **2202** is used instead of SPC **306**. As seen, the IC **2402** requires three dedicated pins for OUT, TDO, and CLK.

The above system examples of FIGS. **24-28** have shown various ways to interface the alternate PSC **2102** and SPC **2202** circuits together such that at most the interface requires three dedicated IC pins for OUT, TDO and CLK, and at least the interface only requires two dedicated pin for OUT and

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TDO. Thus the alternate version of the present disclosure is seen to require only two or three dedicated pins on the target IC.

In reference to FIGS. **14A**, **14B**, **14C**, **23A**, and **23B** it is seen that the frequency of the CKIN and TCK signals is one half the frequency of the source driving the CLK signal. Therefore the JTAG controller and the Tap Domains operate together at one half the frequency of the CLK sources. For example, if the CLK frequency is 100 Mhz, the JTAG operations will occur at 50 Mhz. Thus the second benefit of the present disclosure, stated in the DESCRIPTION OF THE RELATED ART section, of providing a reduced pin interface capable of operating at one half the frequency of the standard 5 pin JTAG interface is achieved.

It should be understood that while the SPC **306** and **2202** of the present disclosure has been shown as it would be used for accessing Tap Domains within ICs, the SPC is not limited to only accessing Tap Domains within ICs. Indeed, as the need may arise, the SPC can be used within embedded core circuits of an IC to allow accessing Tap Domains that exists within those embedded core circuits. The teaching in the present disclosure of how to use an SPC in an IC is sufficiently detailed to enable one skilled in the art to also use the SPC within an embedded core.

Although the present disclosure has been described in detail, it should be understood that various changes, substitutions, and alterations may be made without departing from the spirit and scope of the disclosure as defined by the appended claims.

What is claimed is:

1. A process of operating a state machine having an IN signal input, a Reset input, a Clock input, a Power On Reset input, a Master Reset output, and a Controller Enable output, comprising:

- A. entering a Set Master Reset Low & Poll IN state in response to a signal on one of the Reset input and the Power On Reset input;
- B. outputting a low signal on the Master Reset output while the state machine is in the Set Master Reset Low & Poll IN state;
- C. maintaining the state machine in the Set Master Reset Low & Poll IN state while the IN input is a high signal;
- D. transitioning the state machine from the Set Master Reset Low & Poll IN state to a first POLL IN state when the IN input goes from a high signal to a low signal;
- E. transitioning the state machine from the first POLL IN state to a second POLL IN state when the IN input goes to a low signal and transitioning the state machine from the first POLL IN state to the Set Master Reset Low & Poll IN state when the IN goes to a high signal;
- F. transitioning the state machine from the second POLL IN state to a third POLL IN state when the IN input goes to a high signal and transitioning the state machine from the second POLL IN state to the Set Master Reset Low & Poll IN state when the IN goes to a low signal;
- G. transitioning the state machine from the third POLL IN state to a Set Master Reset & Controller Enable High state when the IN input goes to a high signal and transitioning the state machine from the third POLL IN state to the Set Master Reset Low & Poll IN state when the IN goes to a low signal;
- H. setting the Master Reset output to a high signal and setting the Controller Enable output to a high signal while the state machine is in the Set Master Reset & Controller Enable High state;
- I. maintaining the Set Master Reset Low & Poll IN state while the Reset input is a low signal; and

J. transitioning the state machine from the Set Master Reset Low & Poll IN state to a Set Controller Enable Low state when the Reset input goes to a high signal.

2. The process of claim 1 including maintaining the Master Reset output in a low signal while the state machine is in the first POLL IN state. 5

3. The process of claim 1 including maintaining the Master Reset output in a low signal while the state machine is in the second POLL IN state.

4. The process of claim 1 including maintaining the Master Reset output in a low signal while the state machine is in the third POLL IN state. 10

5. The process of claim 1 including transitioning from one state to another upon a transition between a signal level on the Clock input. 15

6. The process of claim 1 including transitioning from one state to another upon a rising edge of a signal on the Clock input.

7. The process of claim 1 in which the enter the Set Master Reset Low & Poll IN state occurs in response to a low signal on one of the Reset input and the Power On Reset input. 20

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